

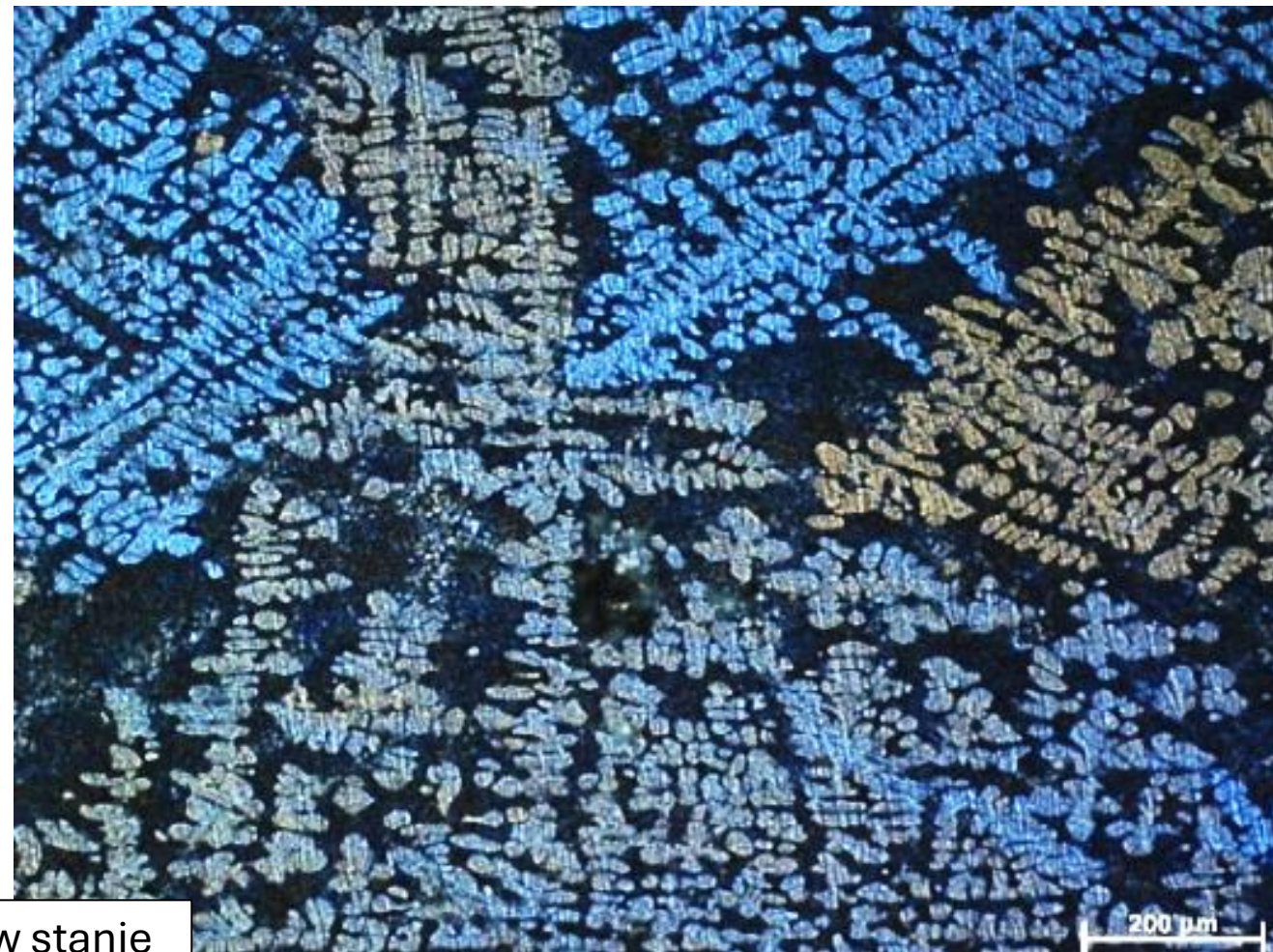
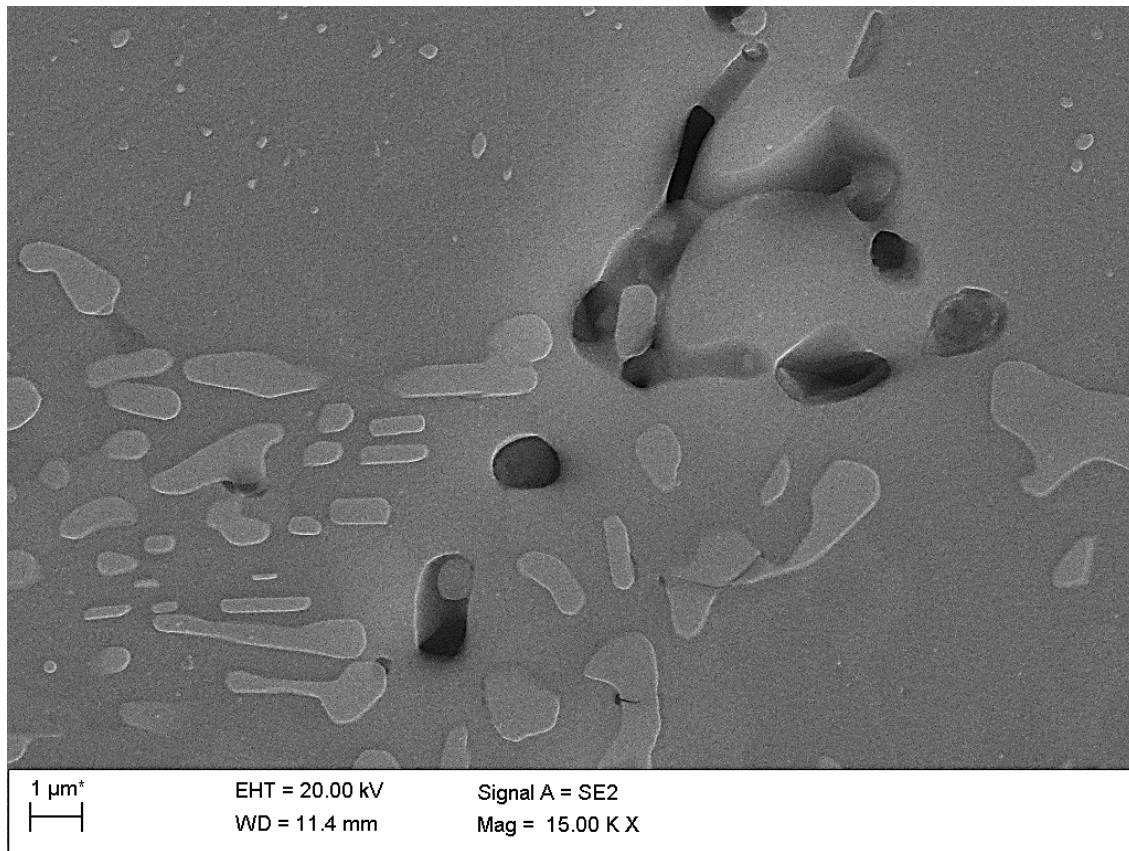
Obróbka cieplna silnie odkształconego stopu AlSi10Mg wytworzonego techniką selektywnego stapiania w łożu proszkowym (SLM)

P Snopiński^{1*}

¹ Department of Engineering Materials and Biomaterials, Silesian University of Technology, Gliwice, Poland

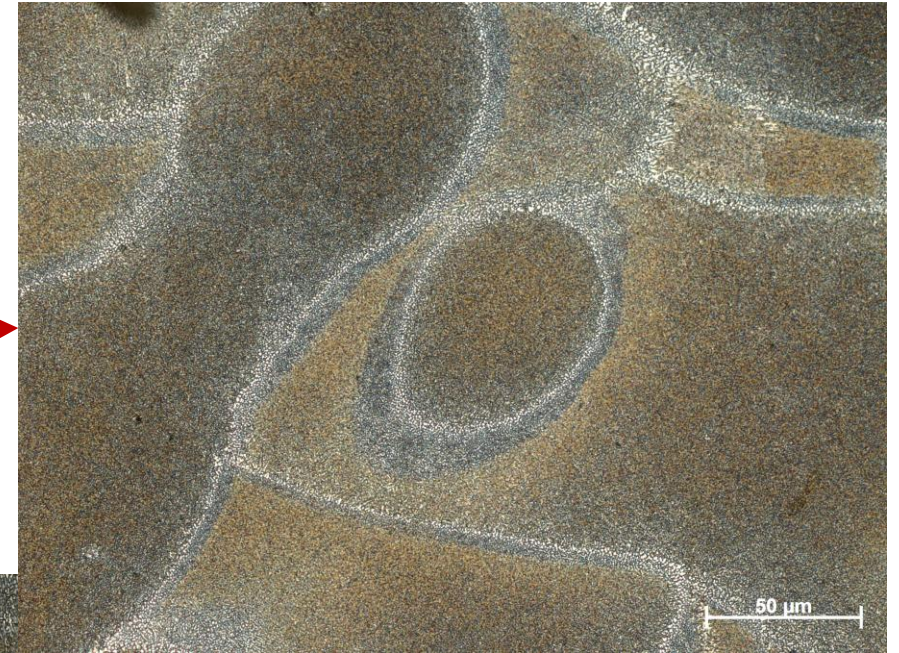
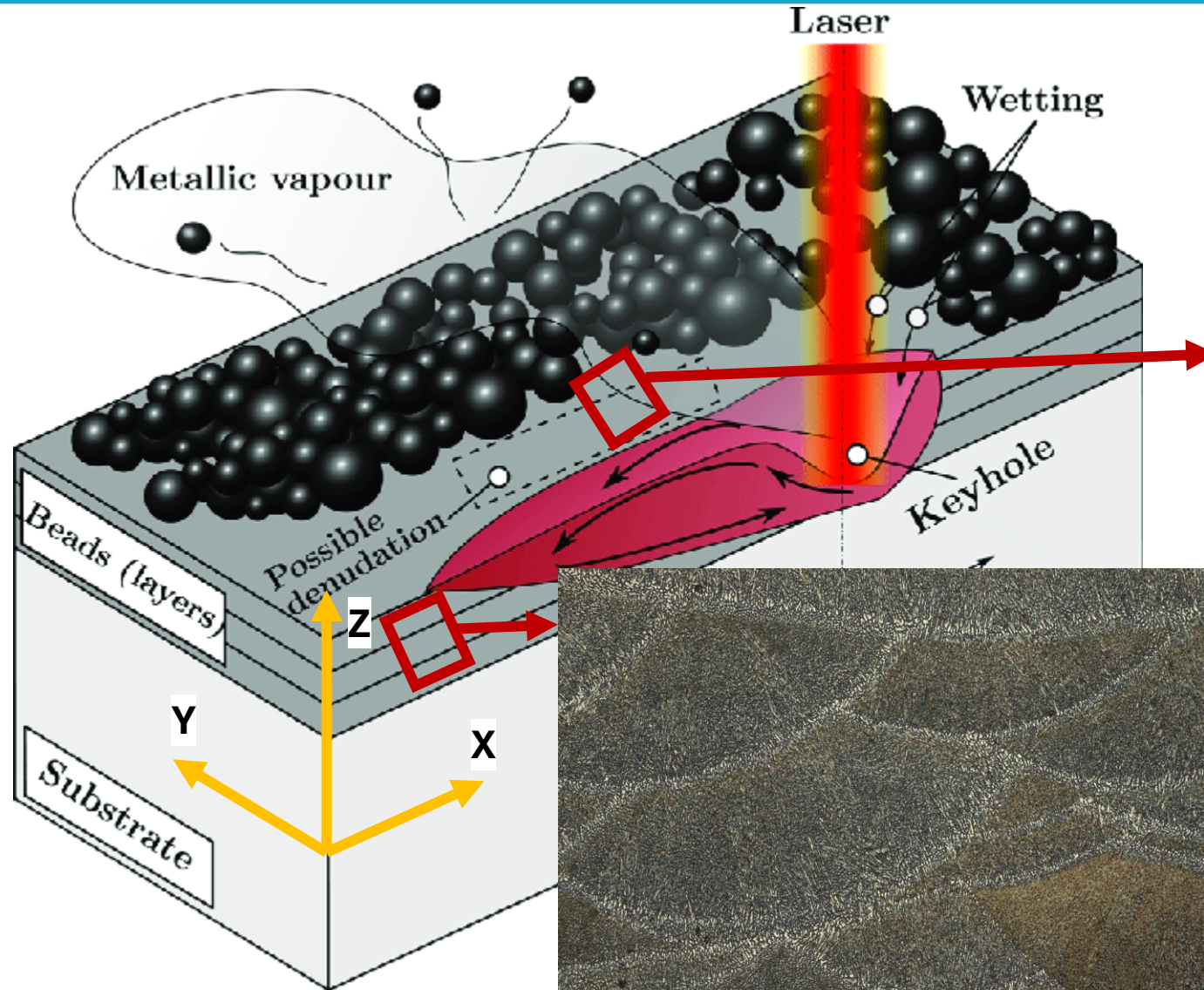


Mikrostruktura stopu AlSi10Mg (ODLEW)



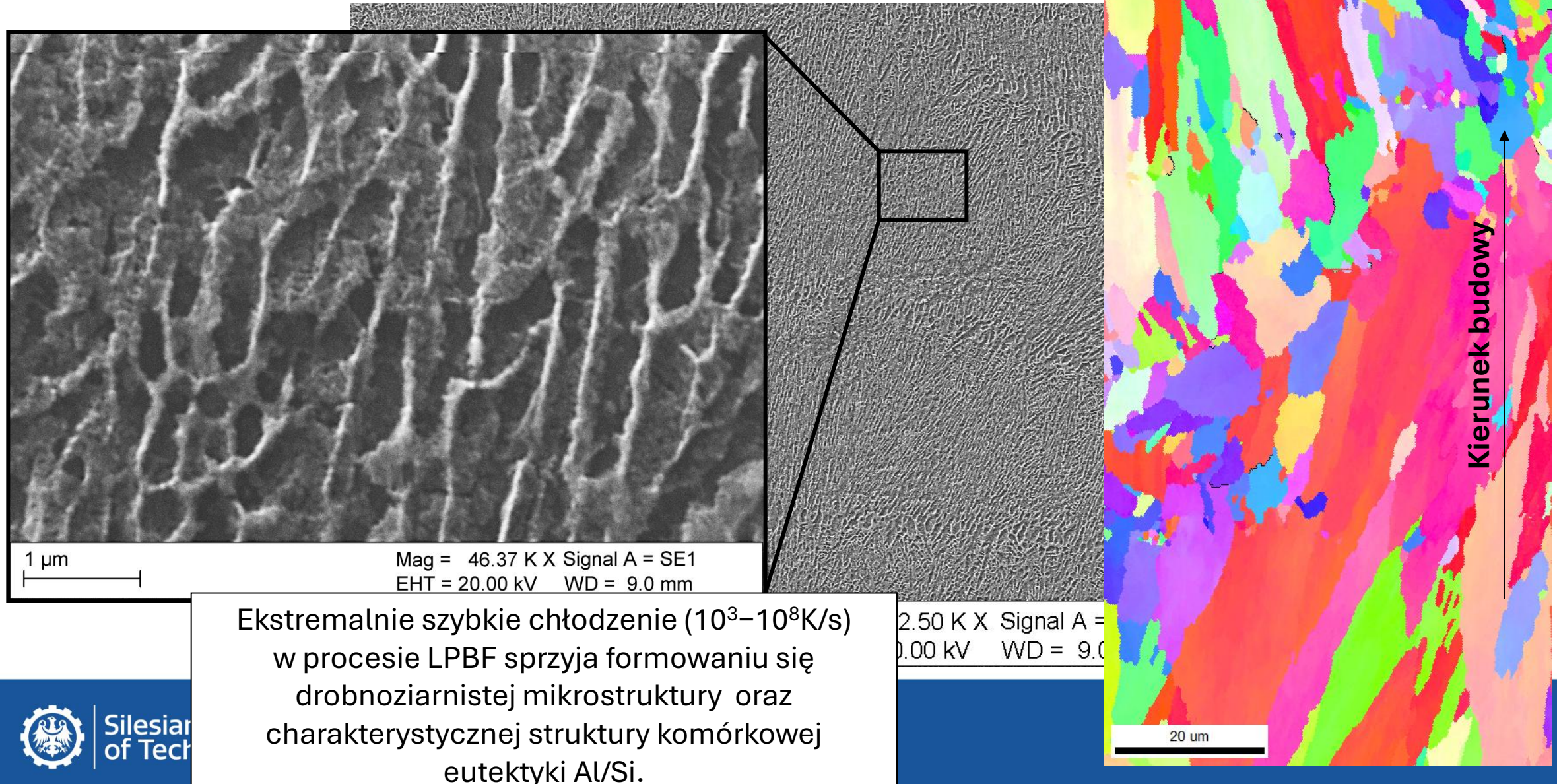
Struktura dendrytyczna stopu AlSi10Mg w stanie odlanym

Proces stapiania w łożu proszkowym (LPBF)

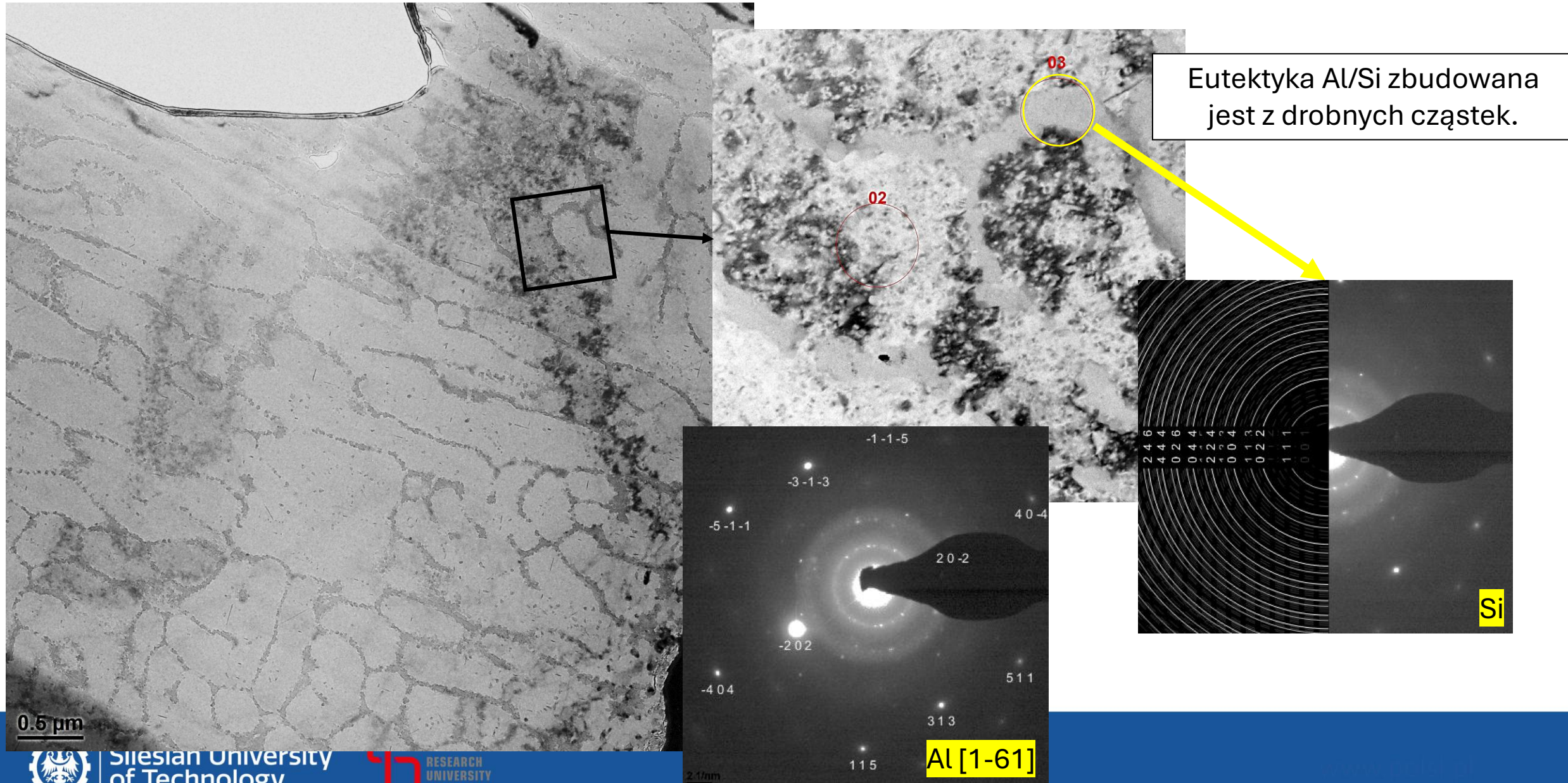


Mikrostruktura stopu
AlSi10Mg (LPBF)

Mikrostruktura stopu AlSi10Mg (LPBF)



Mikrostruktura stopu AlSi10Mg



Właściwości mechaniczne stopu AlSi10Mg

Table 2. Tensile results of as-cast and SLM AlSi10Mg.

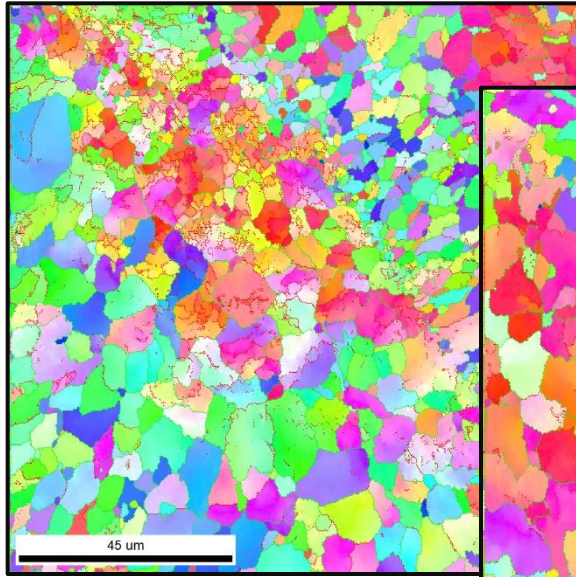
Processing methods	Direction	Temperature	Tensile strength (MPa)	Elongation (%)
Casting	XY	25 °C	312.65 ± 1.34	12.60 ± 0.77
	YZ		315.13 ± 1.33	14.29 ± 0.19
SLM	XY	25 °C	445.34 ± 11.36	8.68 ± 0.02
	YZ		430.04 ± 8.88	8.70 ± 0.82
Casting	XY	230 °C	237.16 ± 6.13	20.47 ± 1.70
	YZ		225.31 ± 5.46	18.67 ± 0.49
SLM	XY	230 °C	266.59 ± 15.25	20.53 ± 1.55
	YZ		270.19 ± 15.86	21.73 ± 1.80

40% wyższe w porównaniu do stopu wytworzonego technologią odlewania.

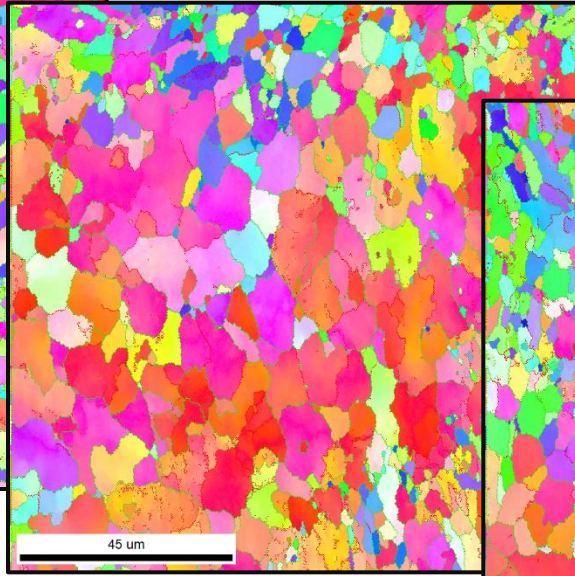
¹Qian Yan, Bo Song, Yusheng Shi, Comparative study of performance comparison of AlSi10Mg alloy prepared by selective laser melting and casting, Journal of Materials Science & Technology, Volume 41, 2020.



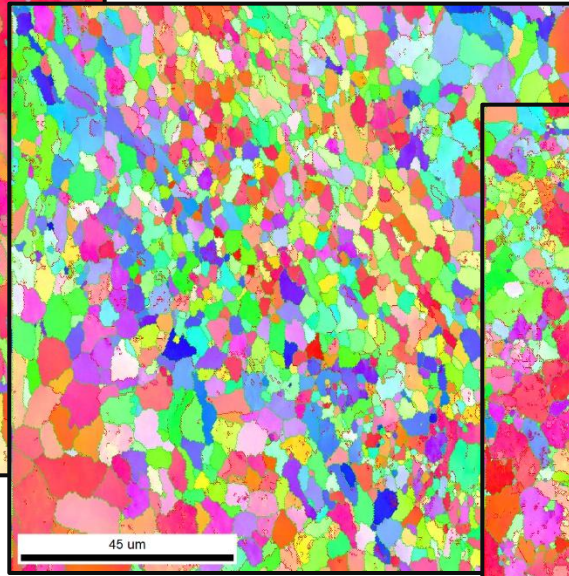
Stabilność termiczna mikrostruktury



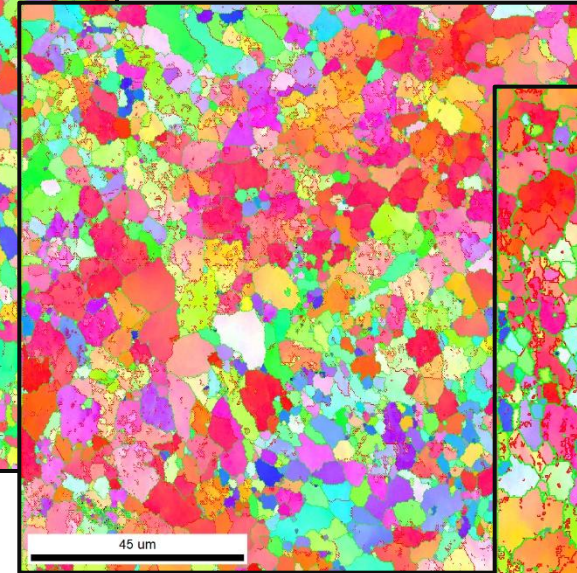
300°C 1h



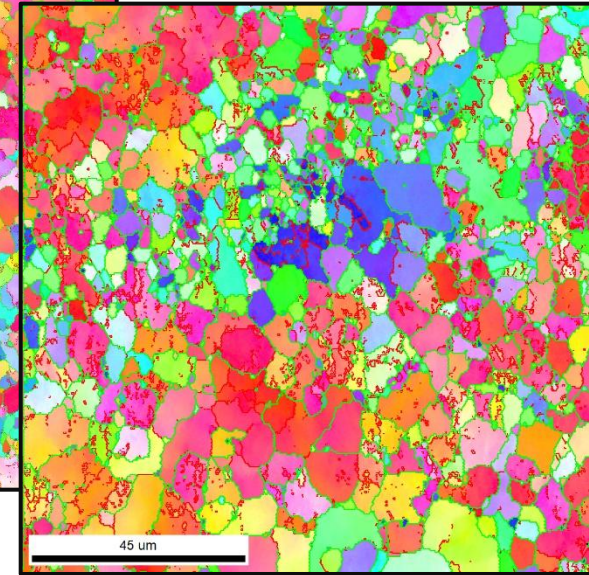
350°C 1h



400°C 1h



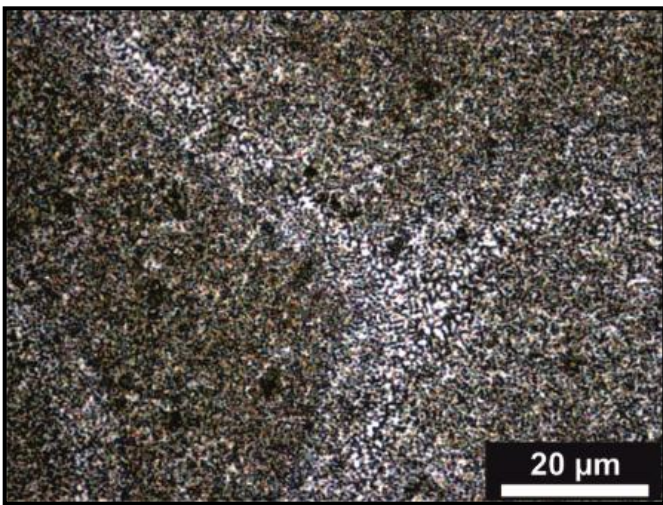
450°C 1h



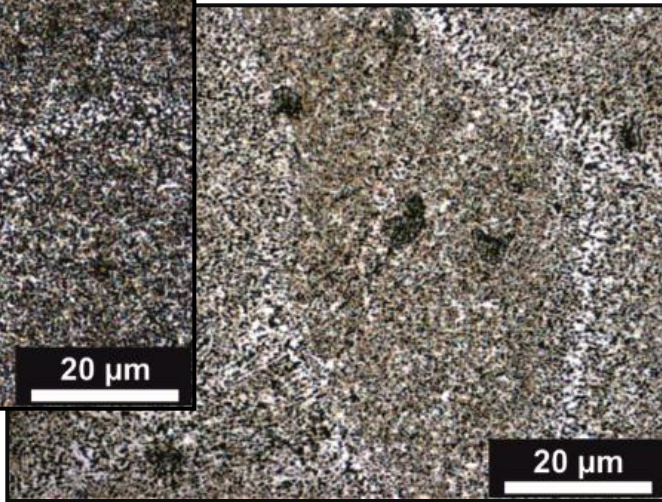
500°C 1h

- Niska energia zmagazynowana w postaci dyslokacji,
- Segregacja pierwiastków hamuje ruchliwość granic ziaren,
- Cząstki Si działają jak punkty kotwiczenia hamując migrację granic,

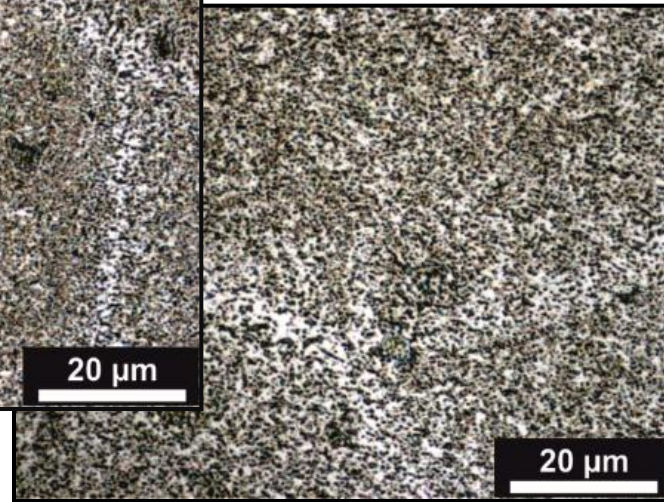
Stabilność termiczna mikrostruktury



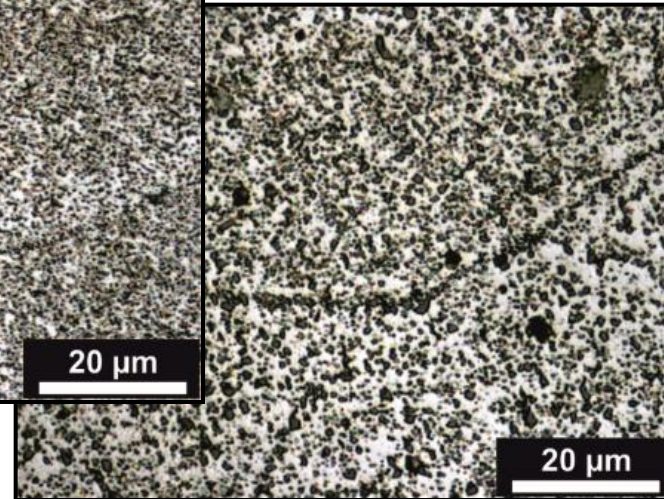
300°C 1h



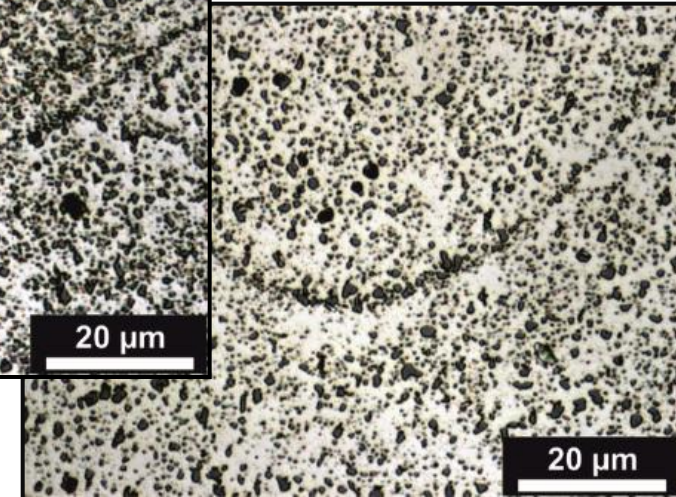
350°C 1h



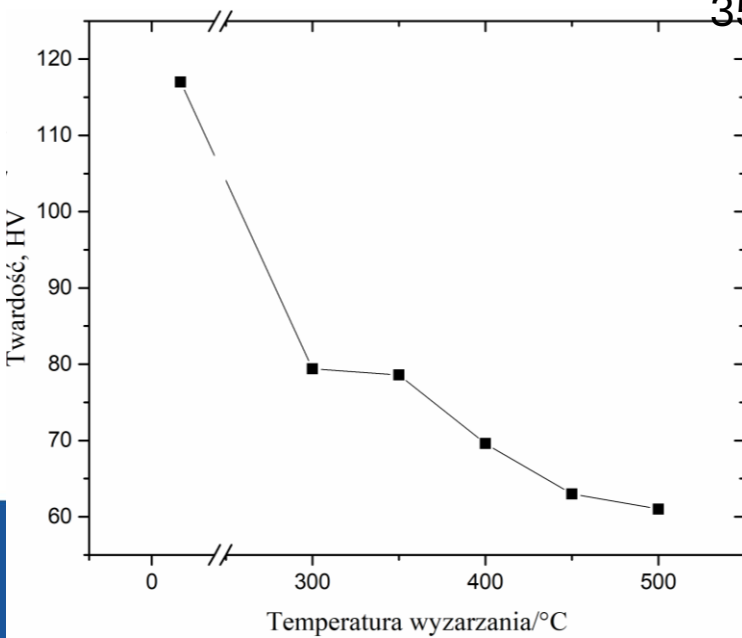
400°C 1h



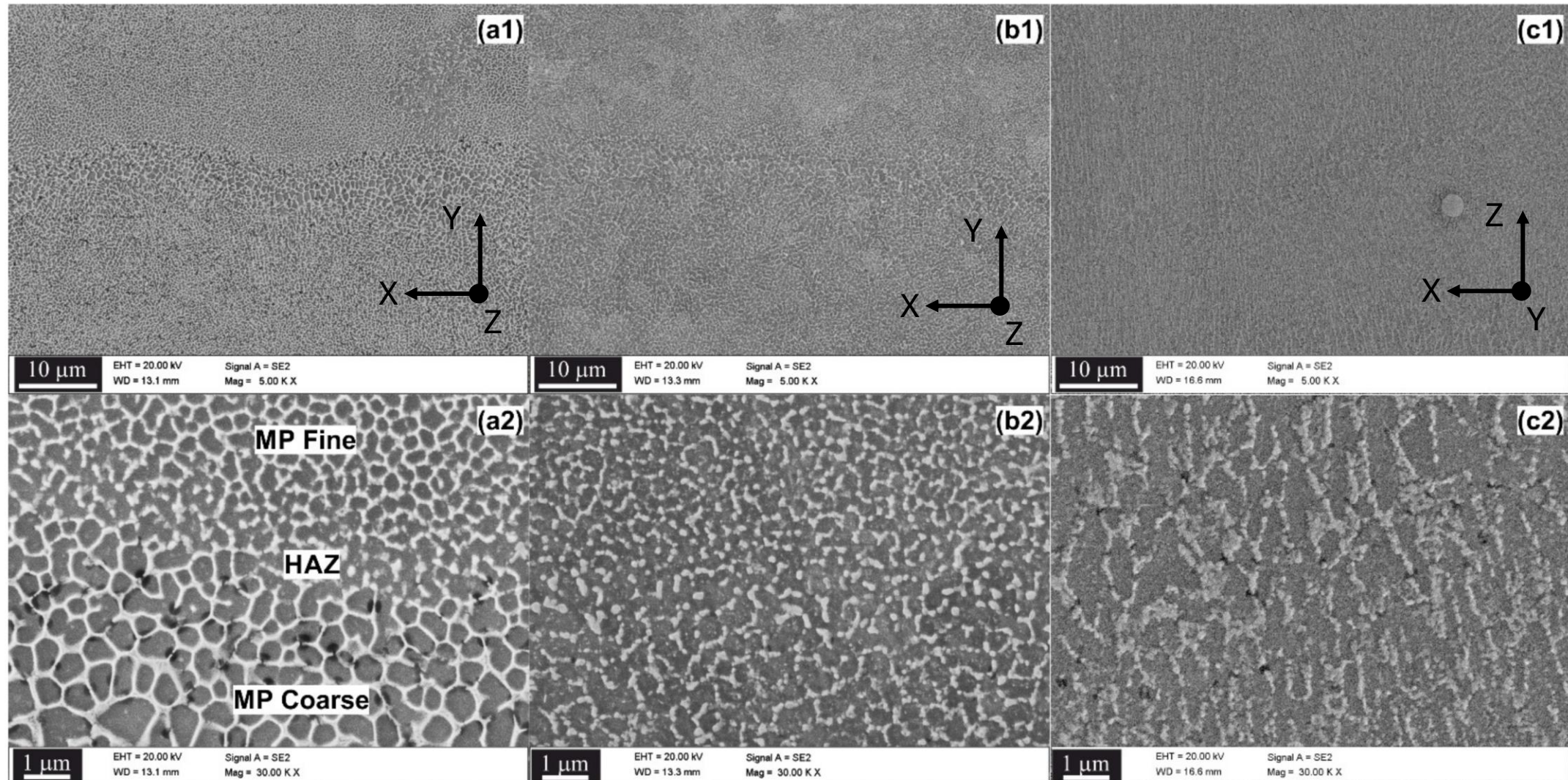
450°C 1h



500°C 1h



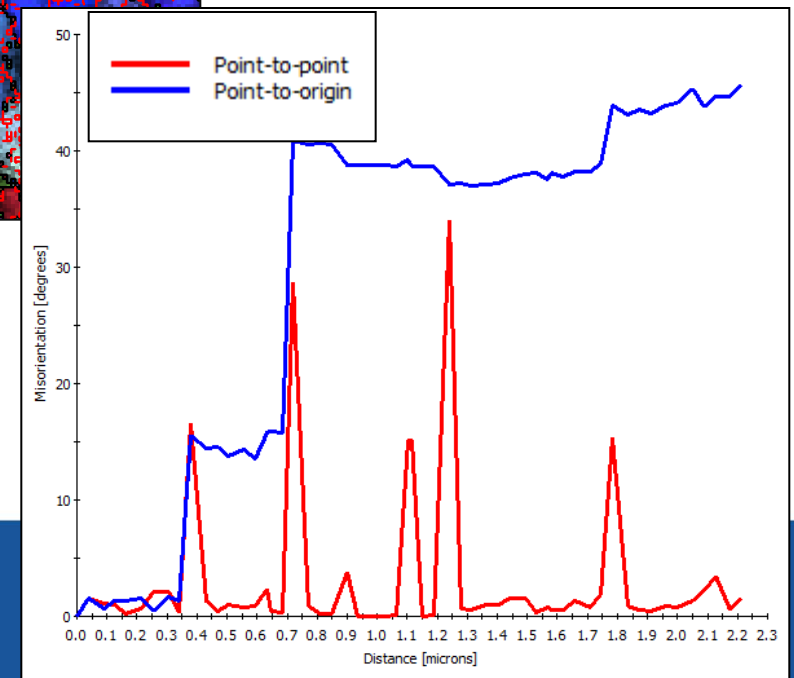
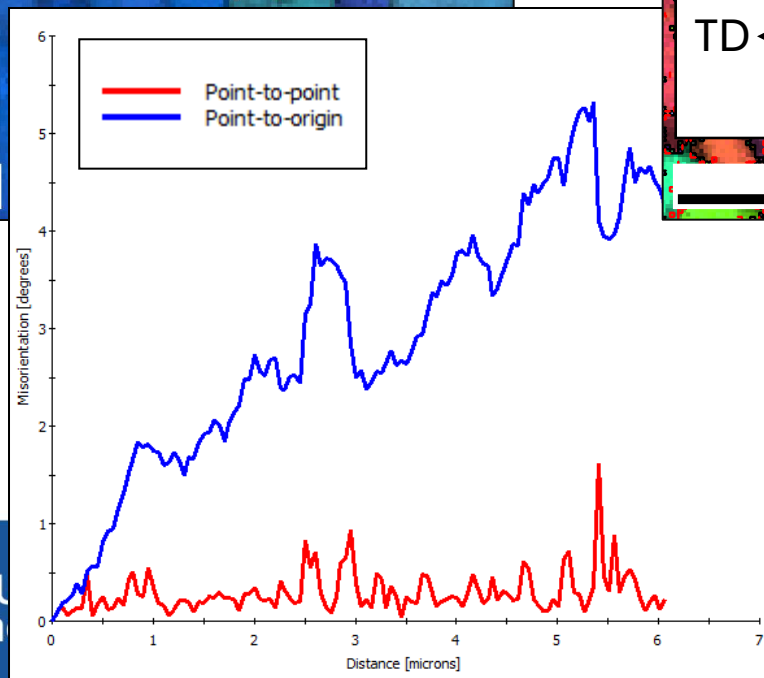
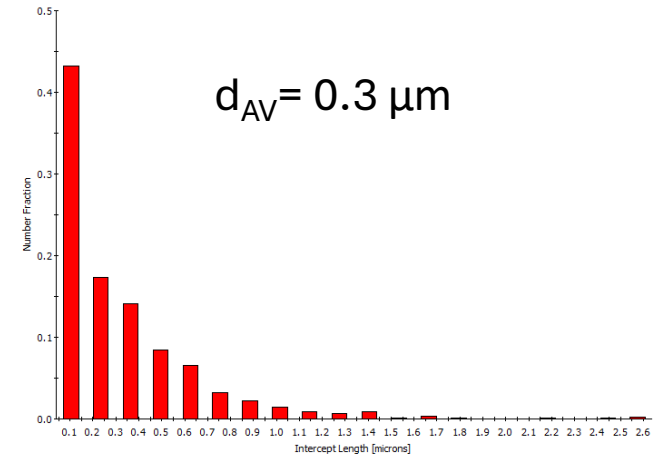
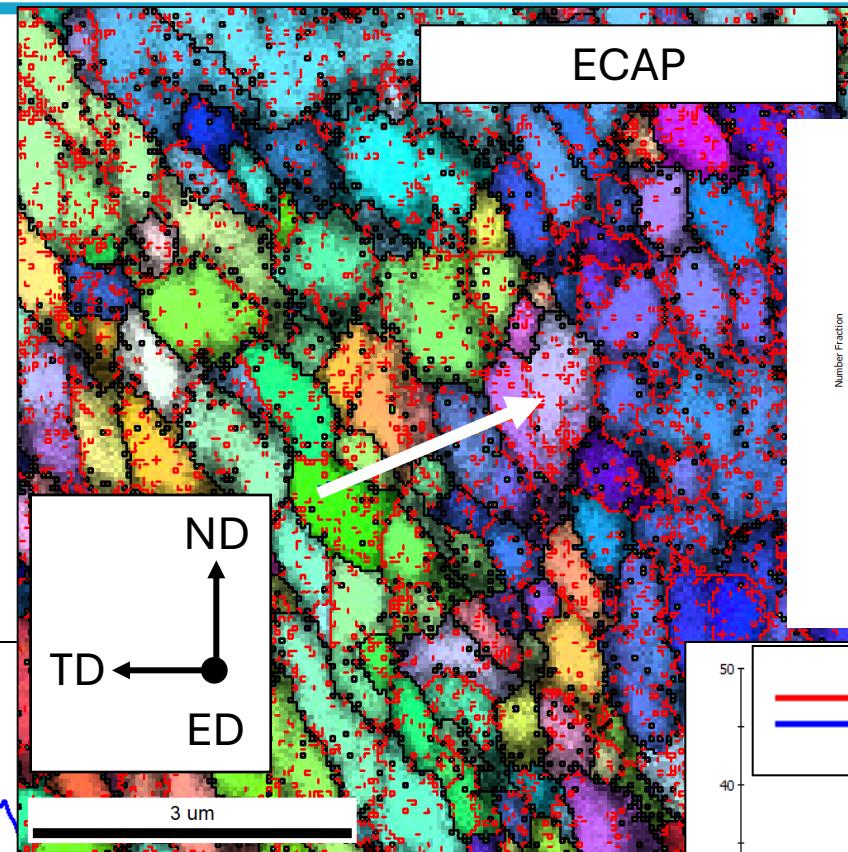
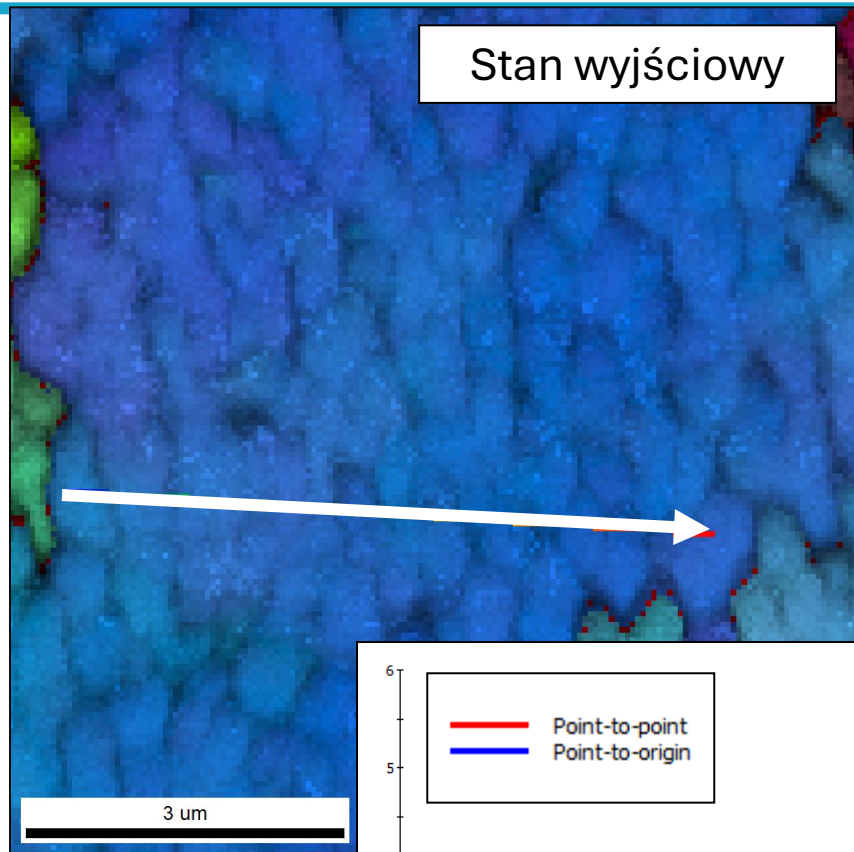
Stabilność termiczna mikrostruktury



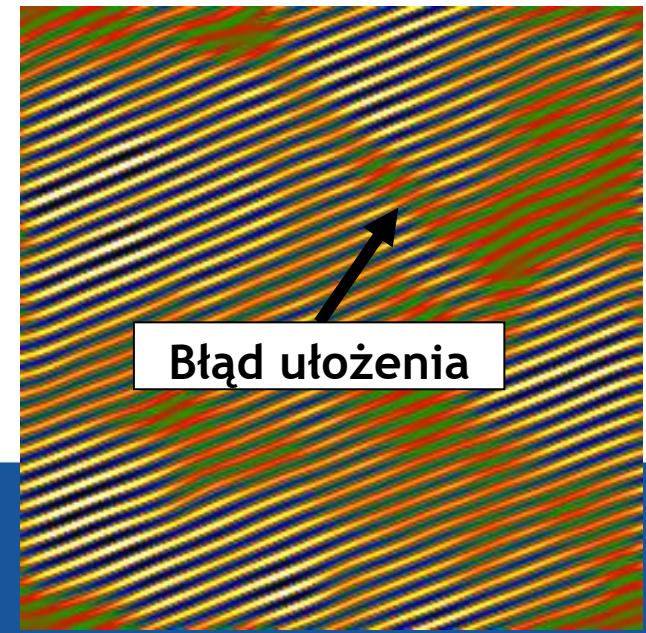
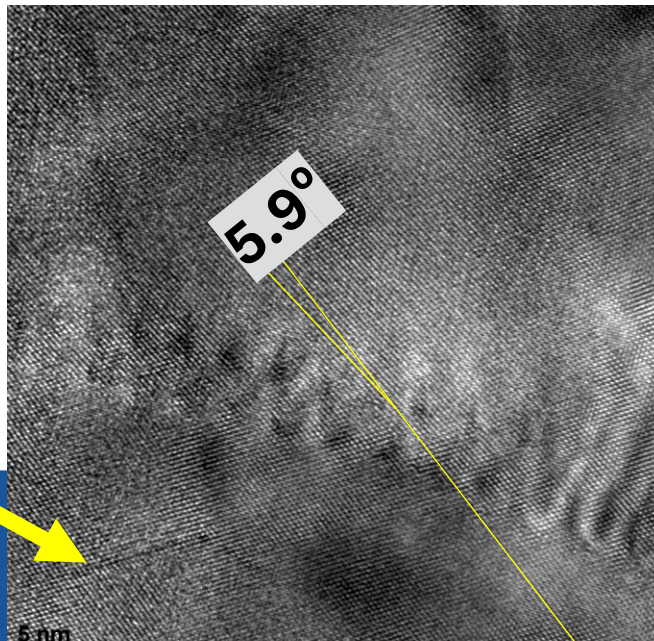
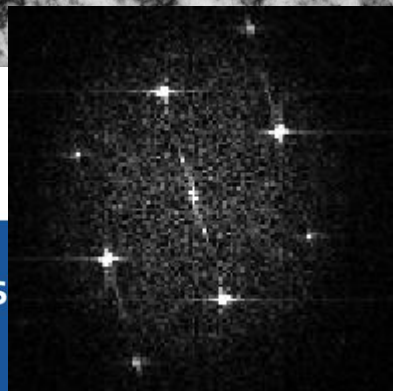
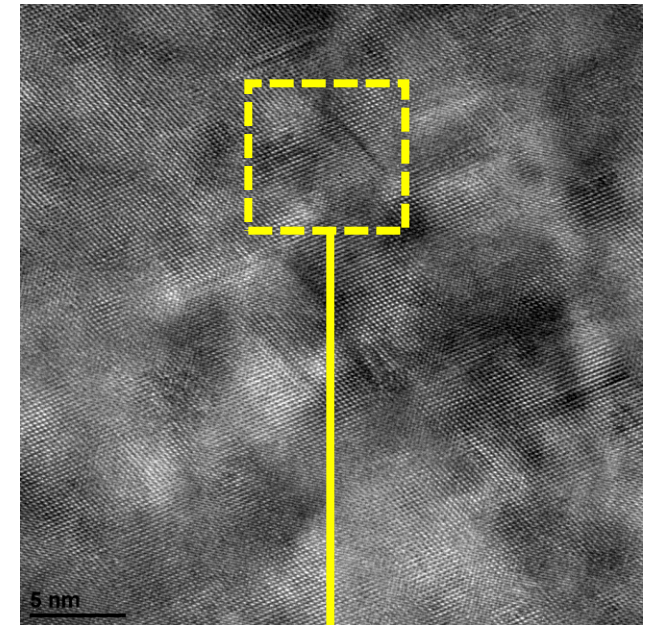
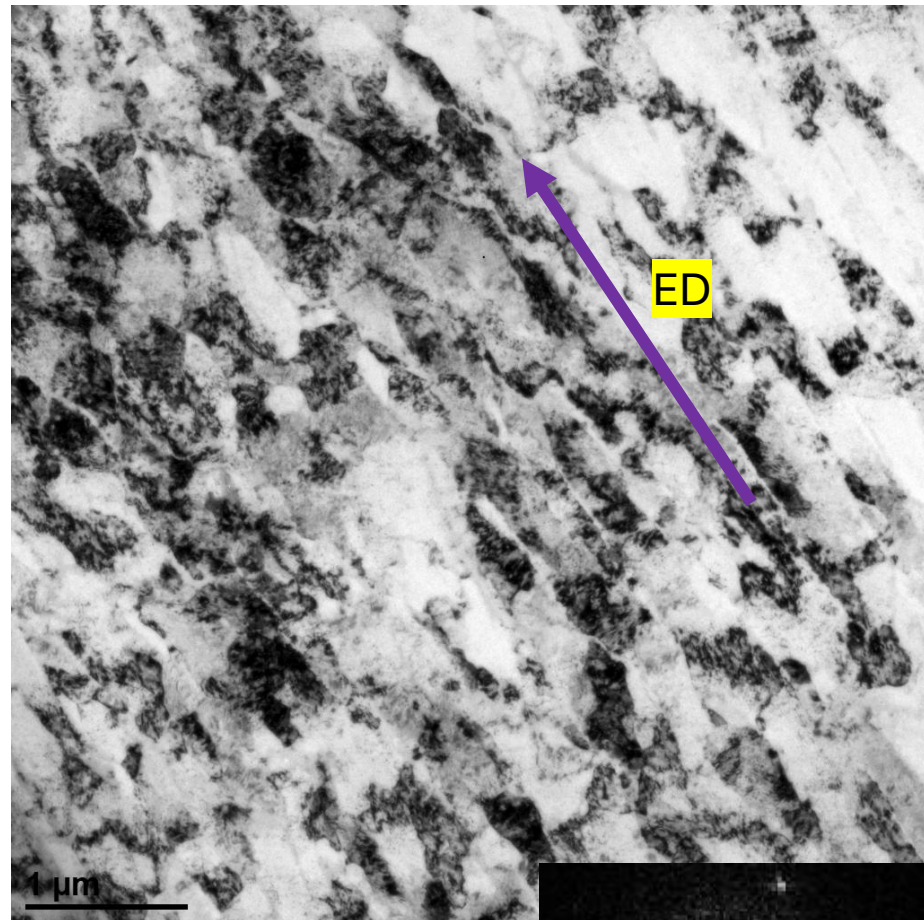
Morfologię eutektyki Al/Si zmodyfikować można stosując krótkotrwałe niskotemperaturowe wyżarzanie. a) stan wyjściowy, b) i c) obrobiony cieplnie 320 °C 9 min



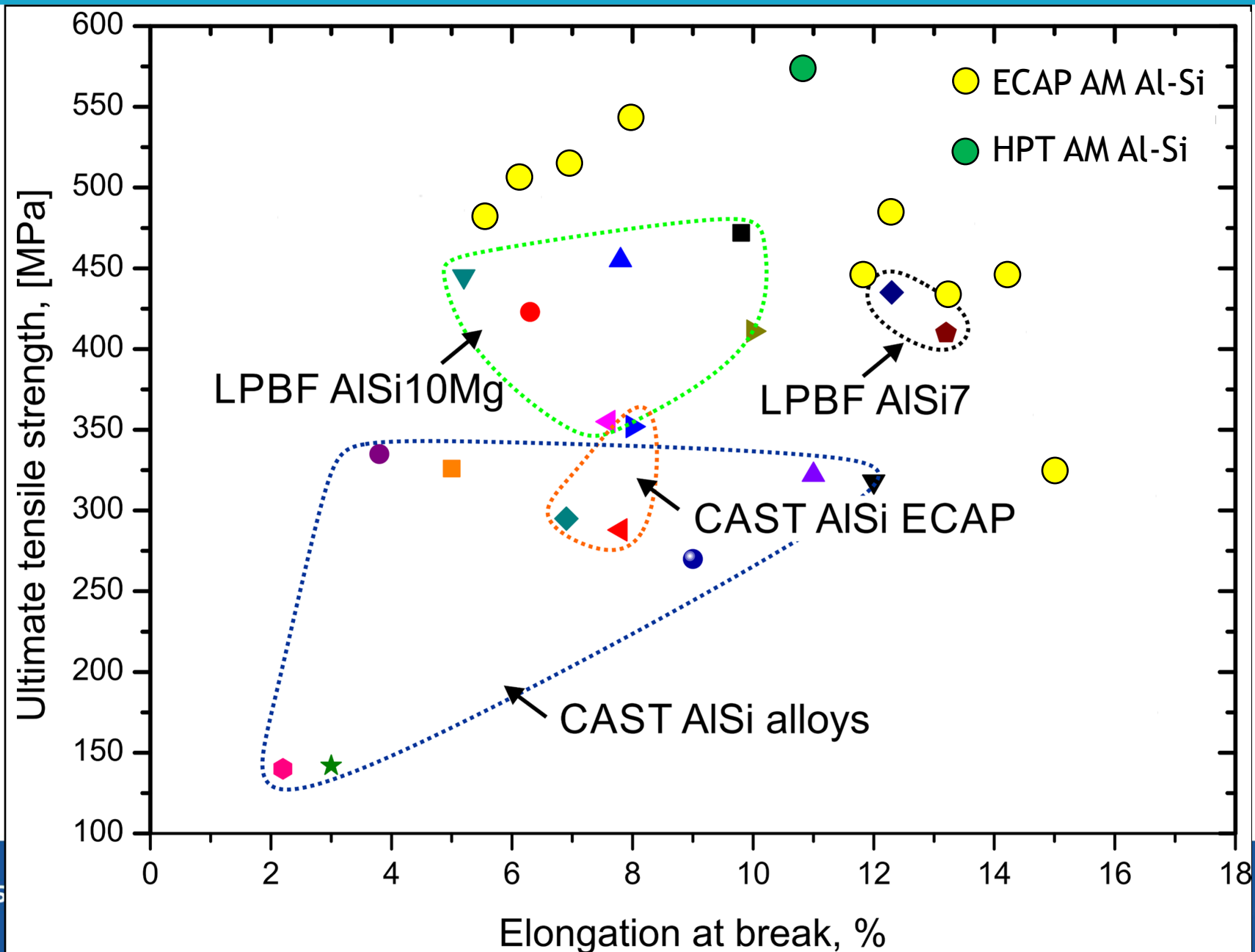
Intensywne odkształcenie plastyczne – LPBF AlSi10Mg



Intensywne odkształcenie plastyczne – LPBF AlSi10Mg



Intensywne odkształcenie plastyczne – LPBF AlSi10Mg

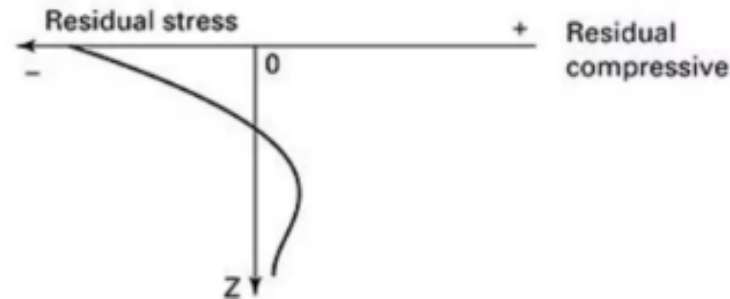
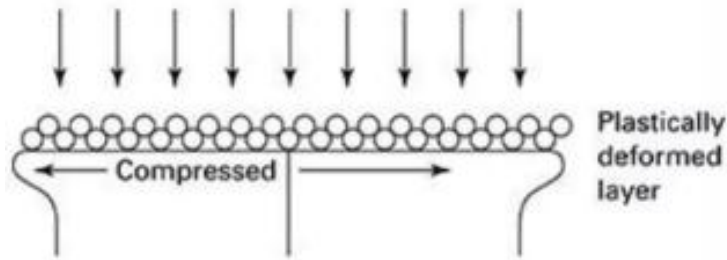


STABILNOŚĆ TERMICZNA MIKROSTRUKTURY STOPU ALSi10MG PO PROCESIE ŚRUTOWANIA (SHOT PEENING)



Proces śrutowania (shot peening)

- Jest to proces obróbki plastycznej na zimno,
- Cel – wytworzenie naprężeń ściskających,
- Zastosowanie – poprawa wytrzymałości zmęczeniowej komponentów z druku 3D,



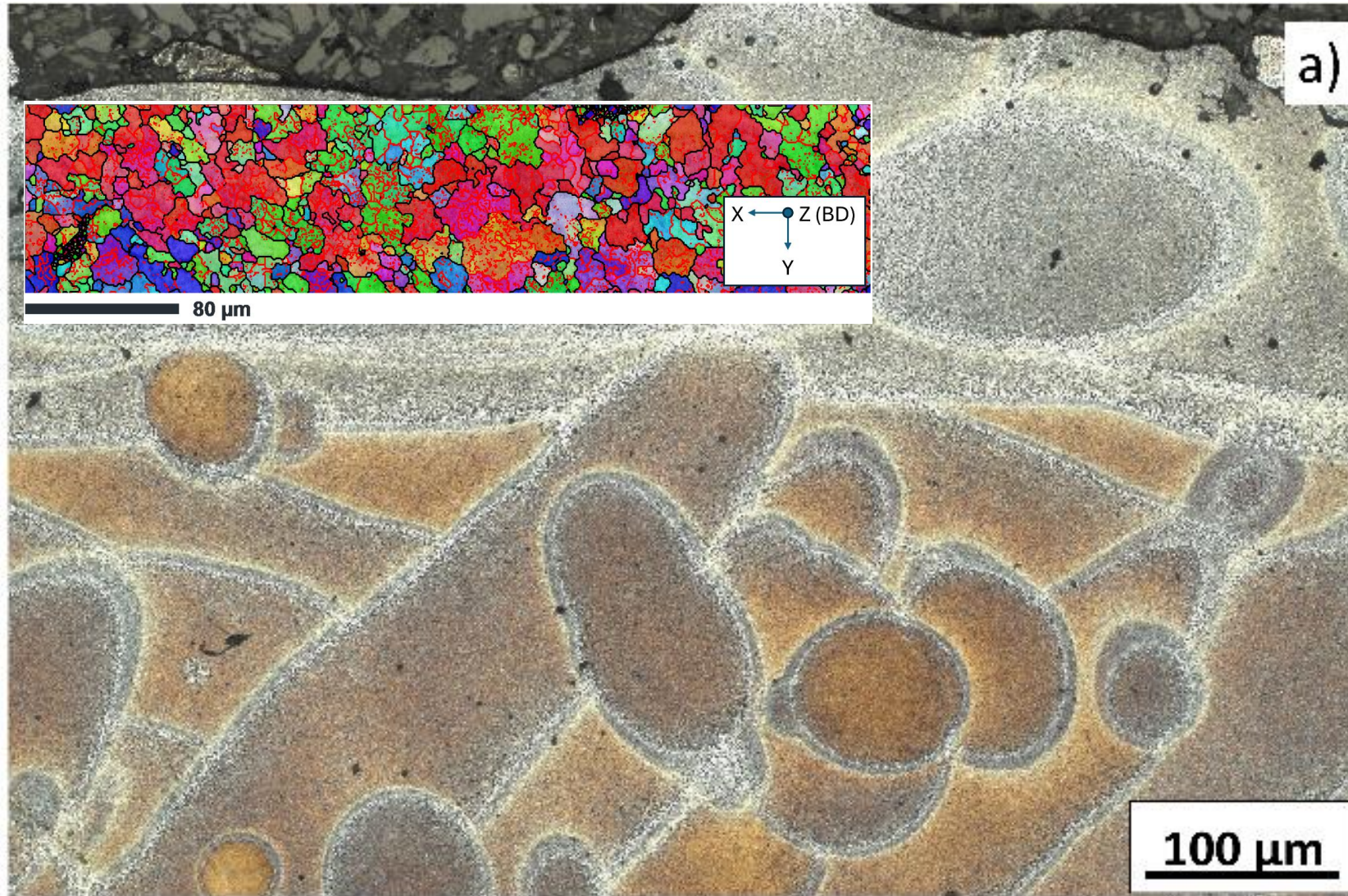
Nozzle



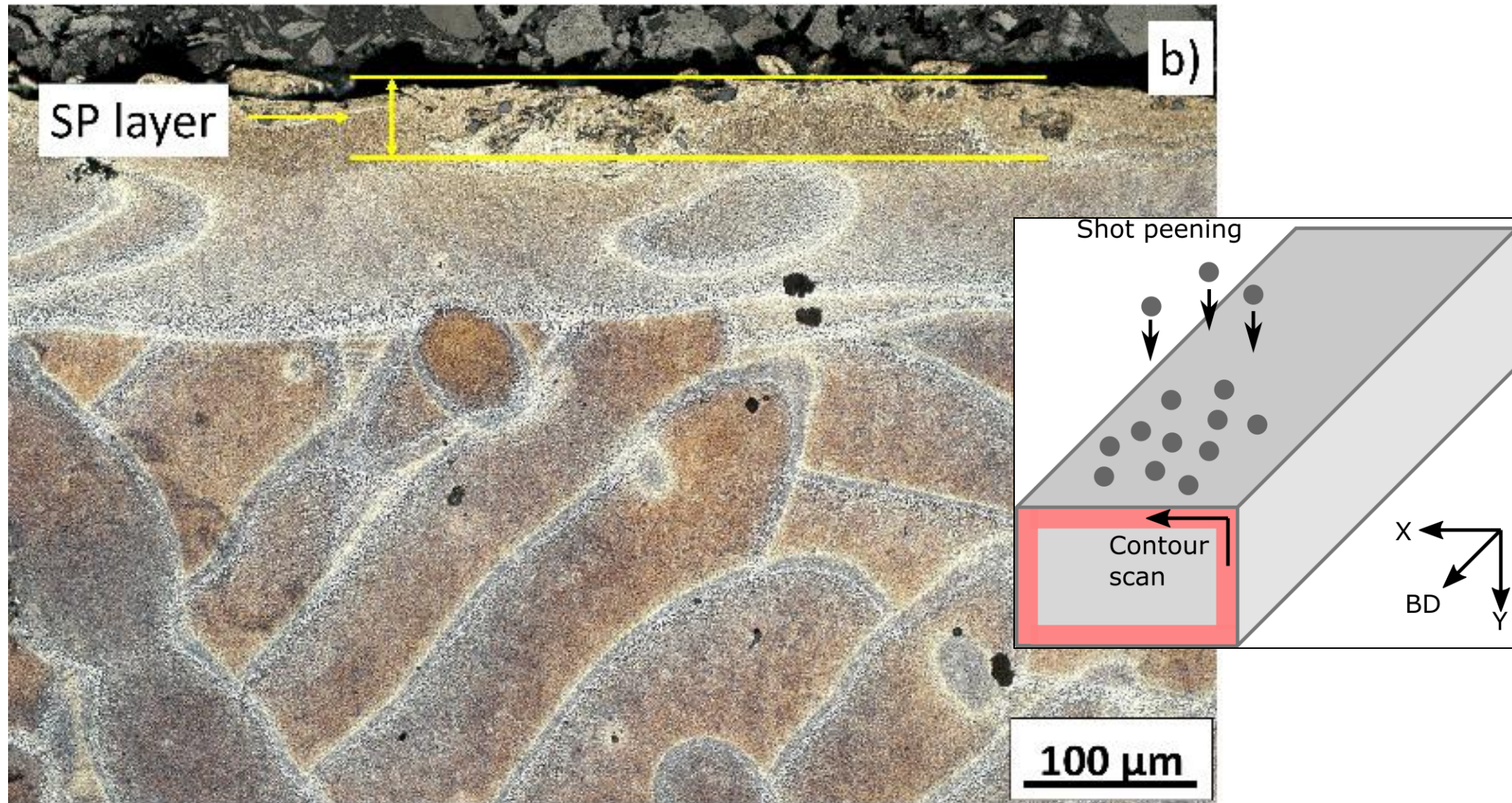
Target



Mikrostruktura stopu AlSi10Mg przed procesem śrutowania



Mikrostruktura stopu AlSi10Mg po procesie śrutowania



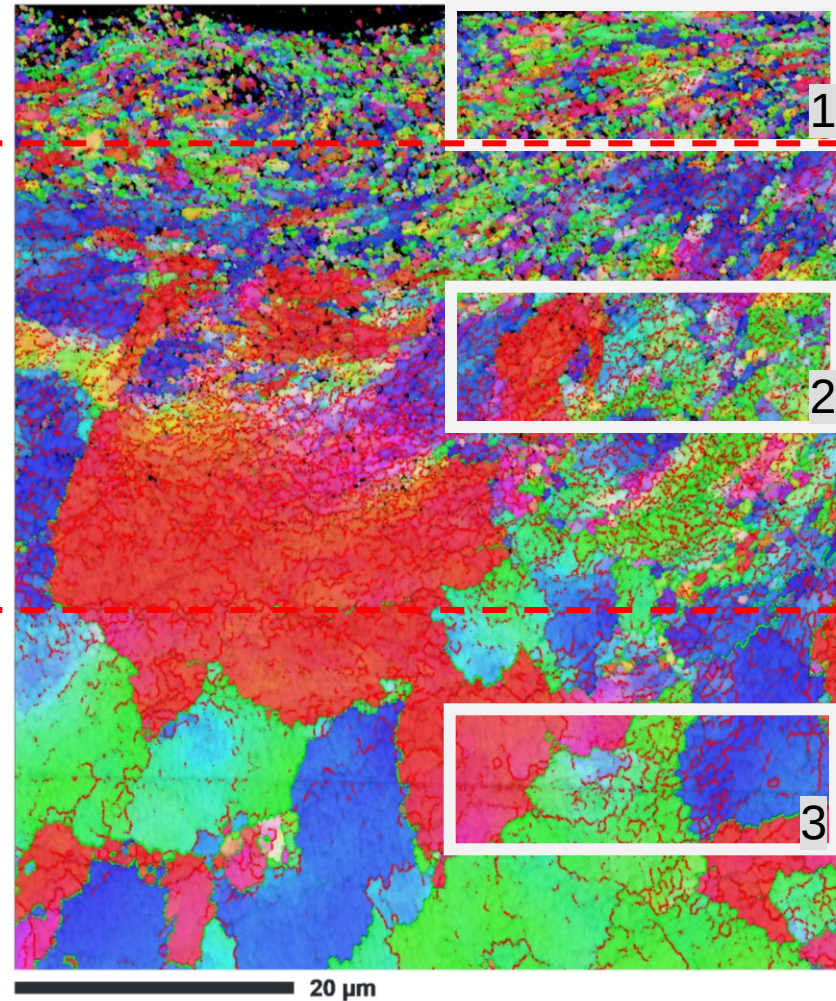
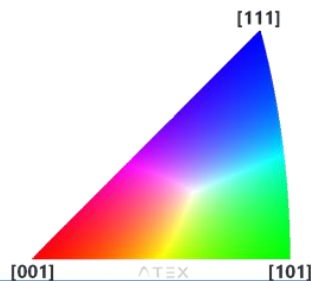
Mikrostruktura stopu AlSi10Mg po procesie śrutowania

Plastically deformed layer

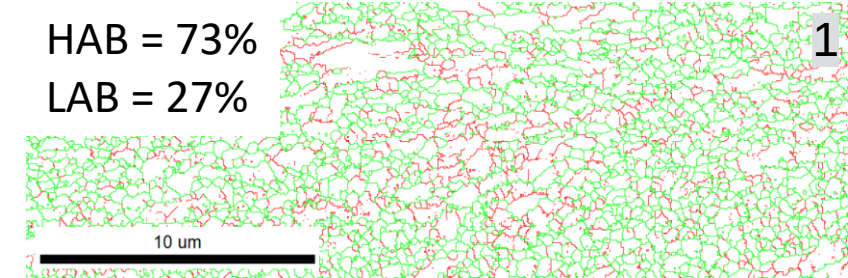
- Wysoka energia odkształcenia,
- Duża powierzchnia granic ziaren,
- Gradient naprężeń (ściskające/rozciągające).

Sub-surface region

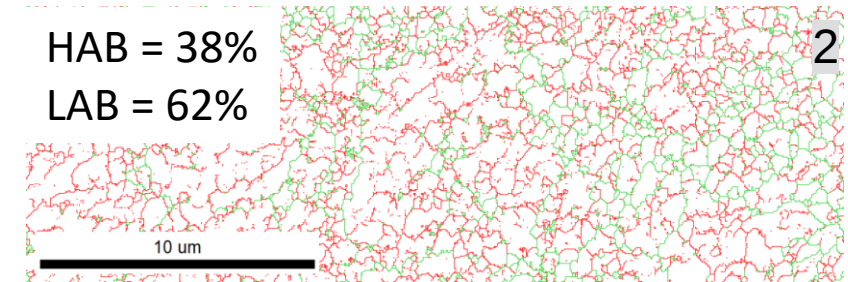
Base material



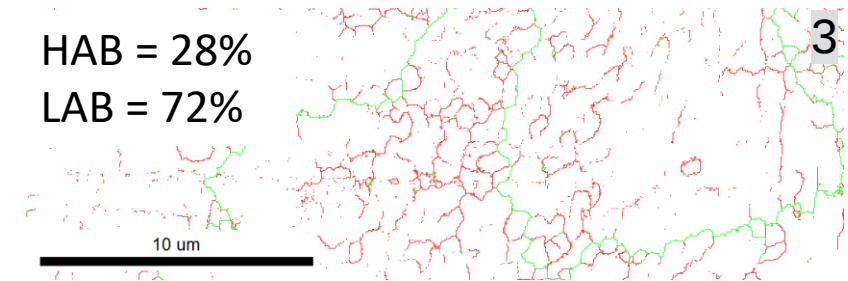
HAB = 73%
LAB = 27%



HAB = 38%
LAB = 62%



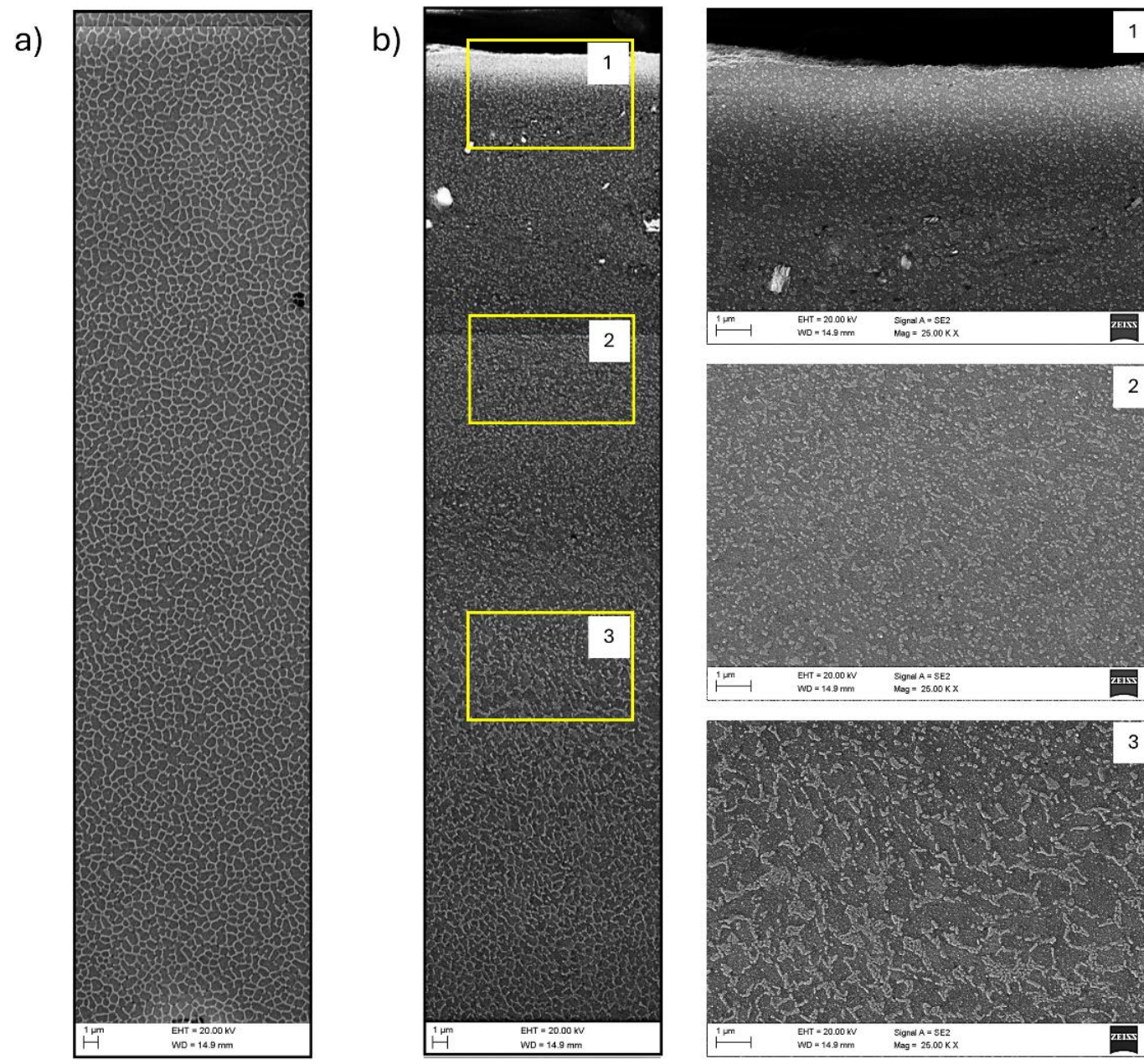
HAB = 28%
LAB = 72%



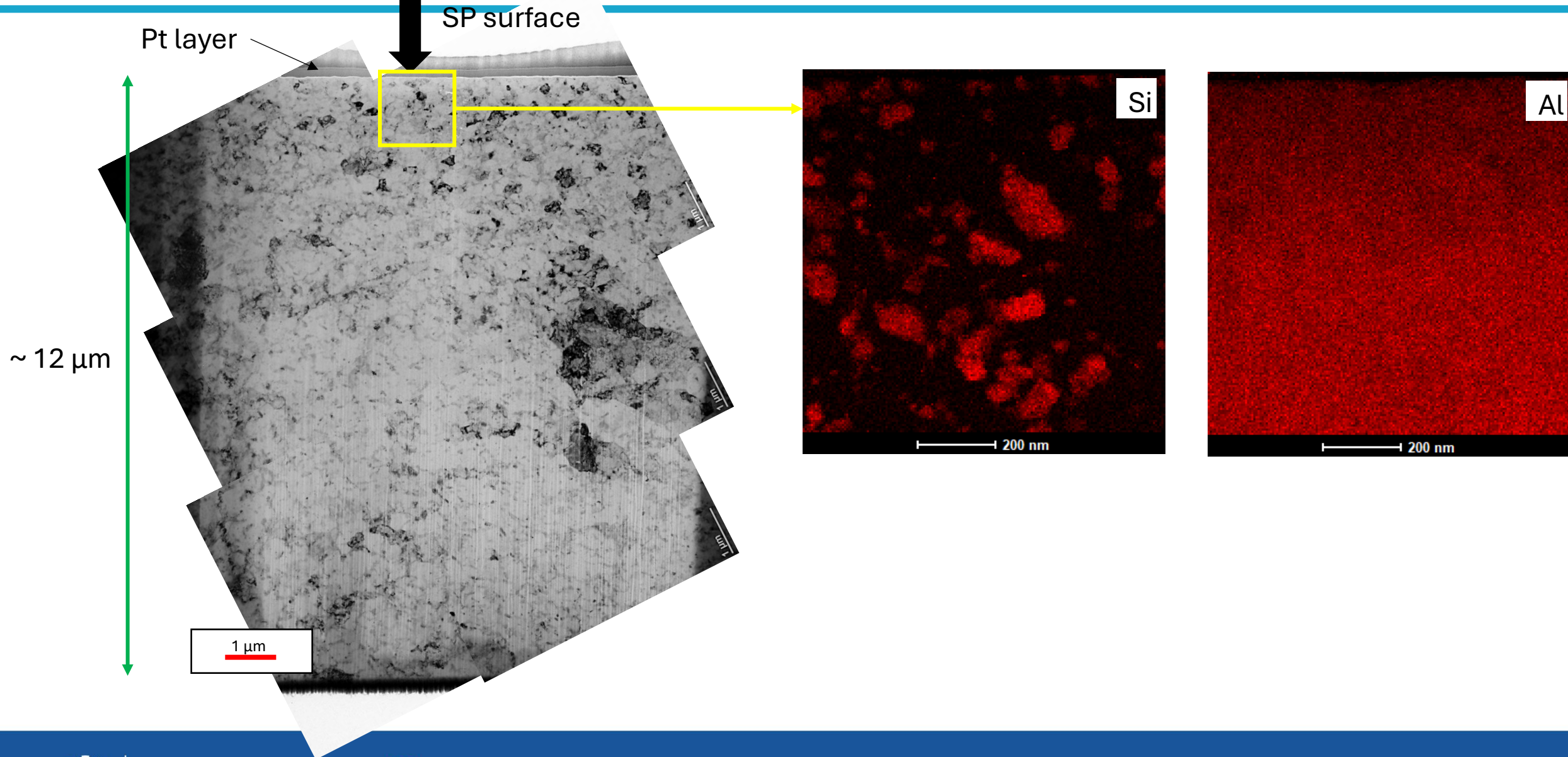
LAB $2^\circ < \theta < 15^\circ$

HAB $15^\circ < \theta < 65^\circ$

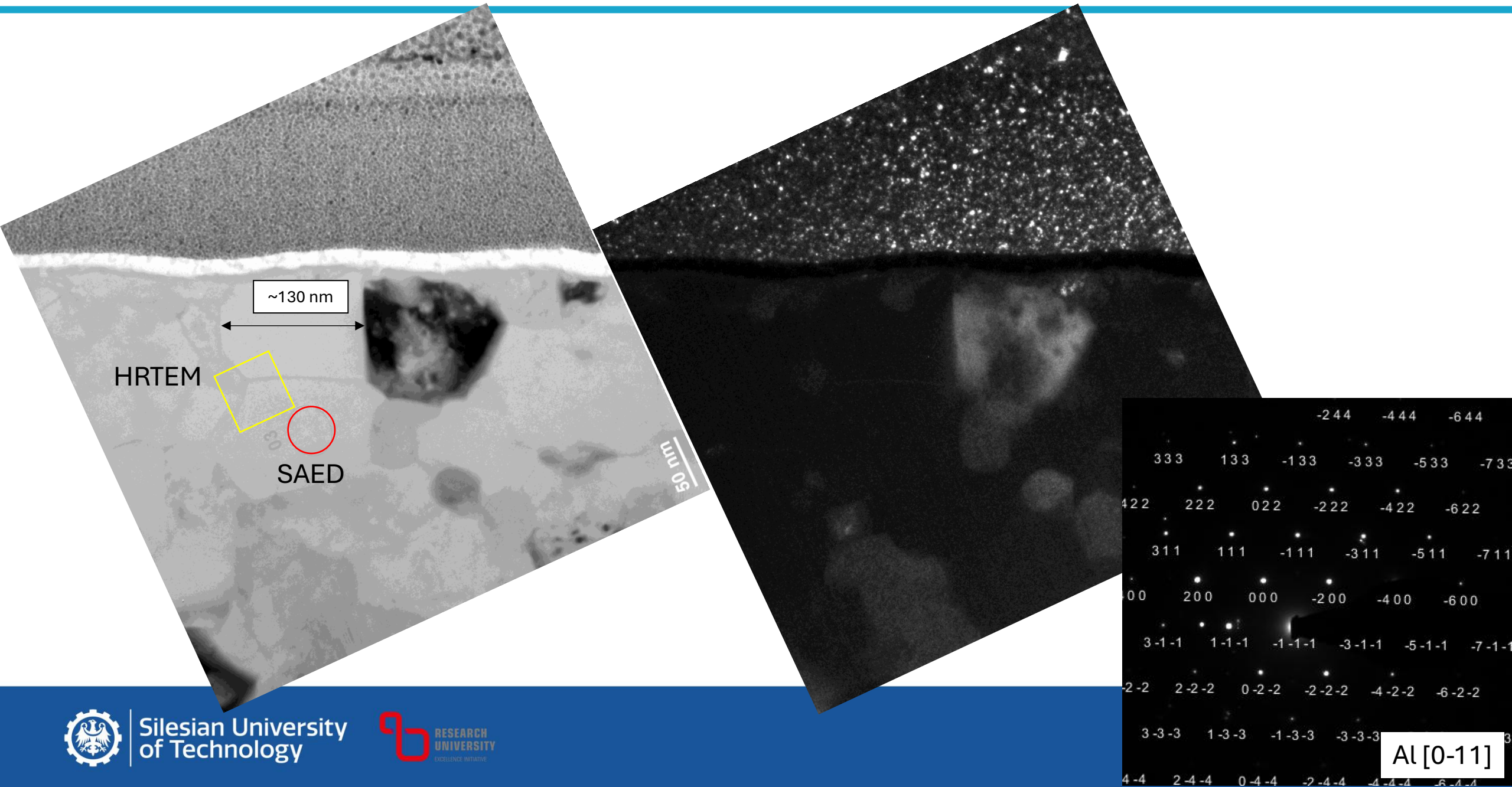
Mikrostruktura stopu AlSi10Mg po procesie śrutowania



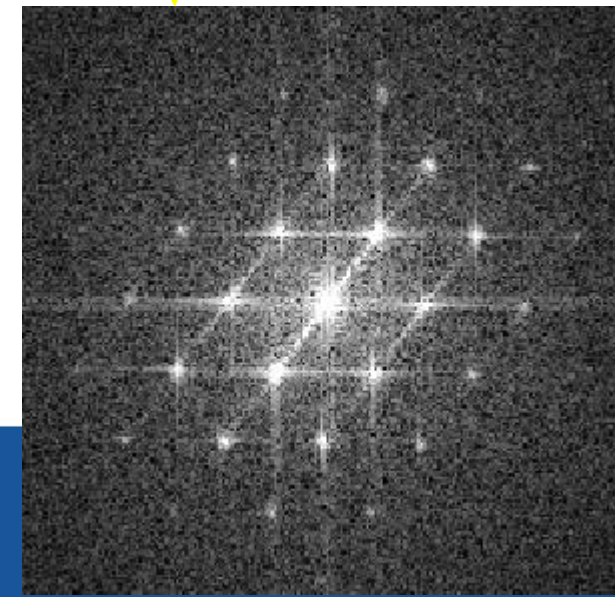
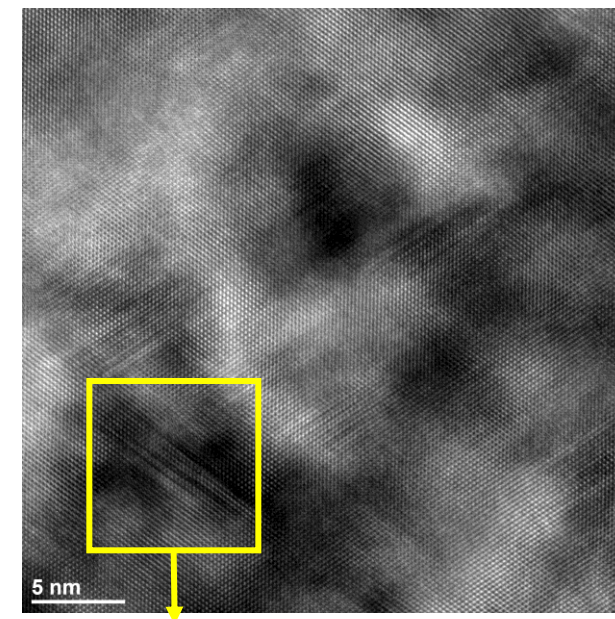
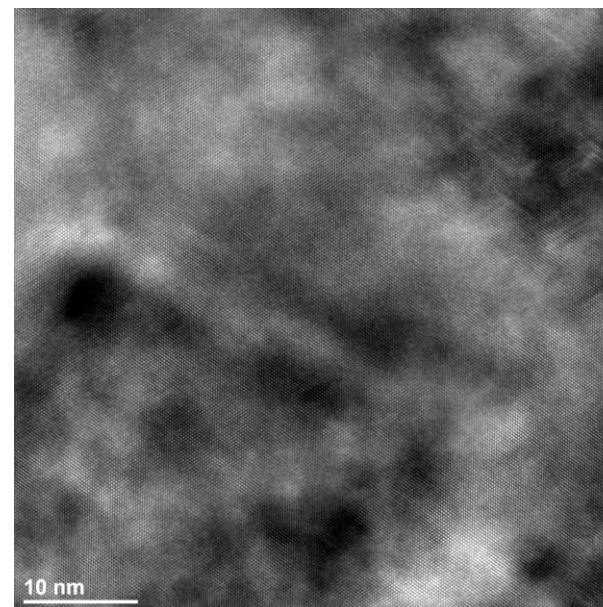
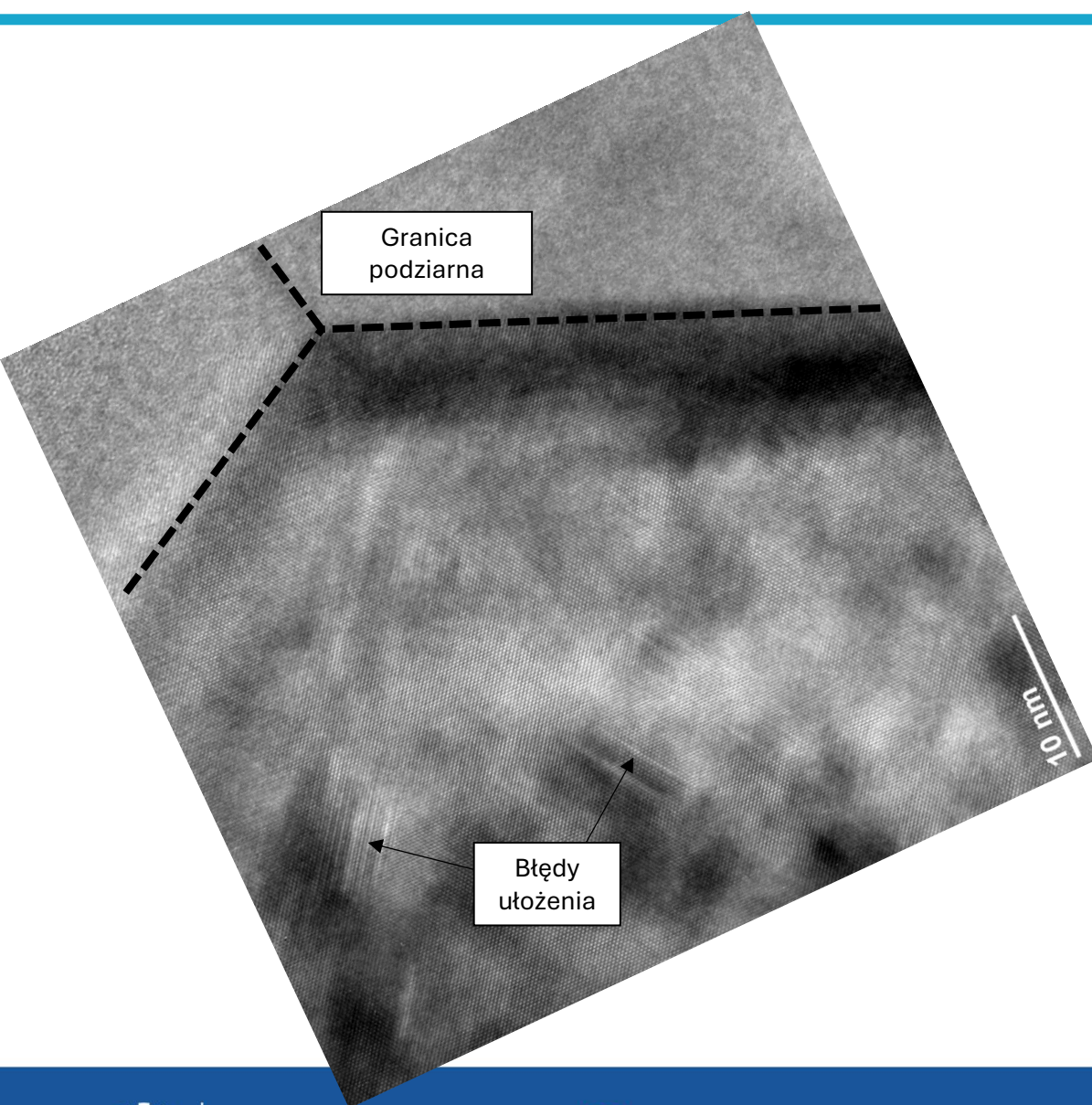
Mikrostruktura stopu AlSi10Mg po procesie śrutowania



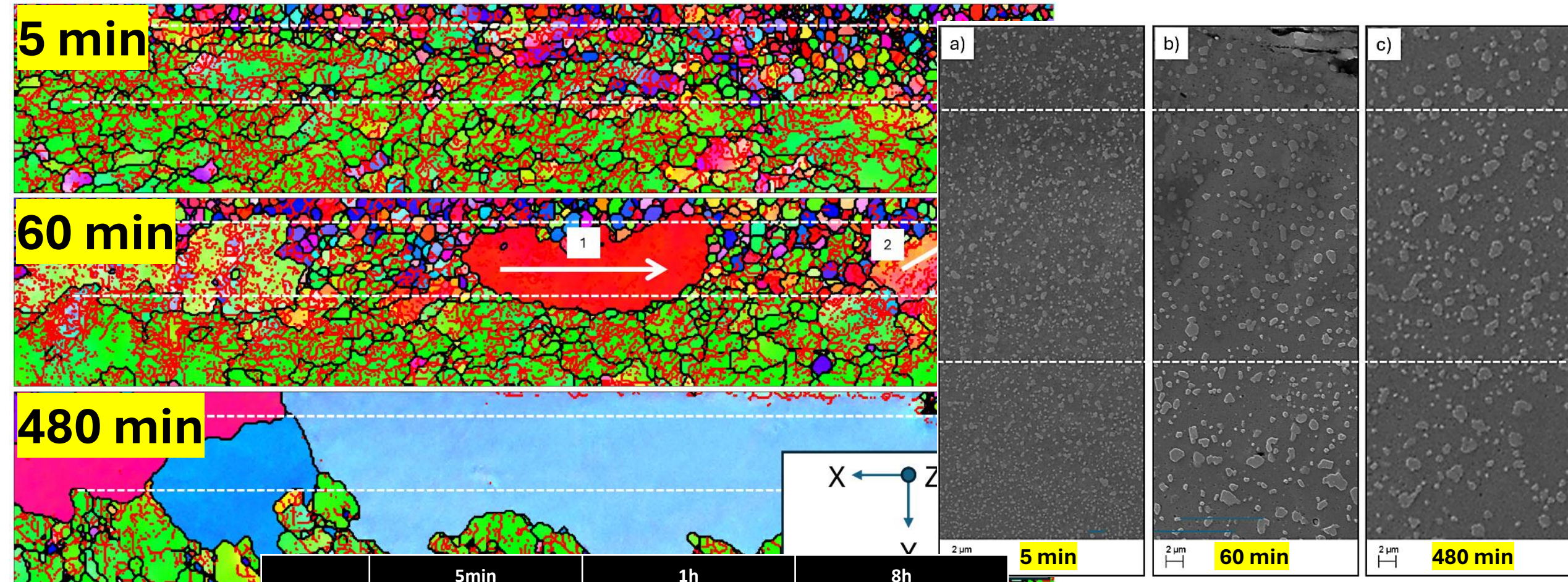
Mikrostruktura stopu AlSi10Mg po procesie śrutowania



Mikrostruktura stopu AlSi10Mg po procesie śrutowania



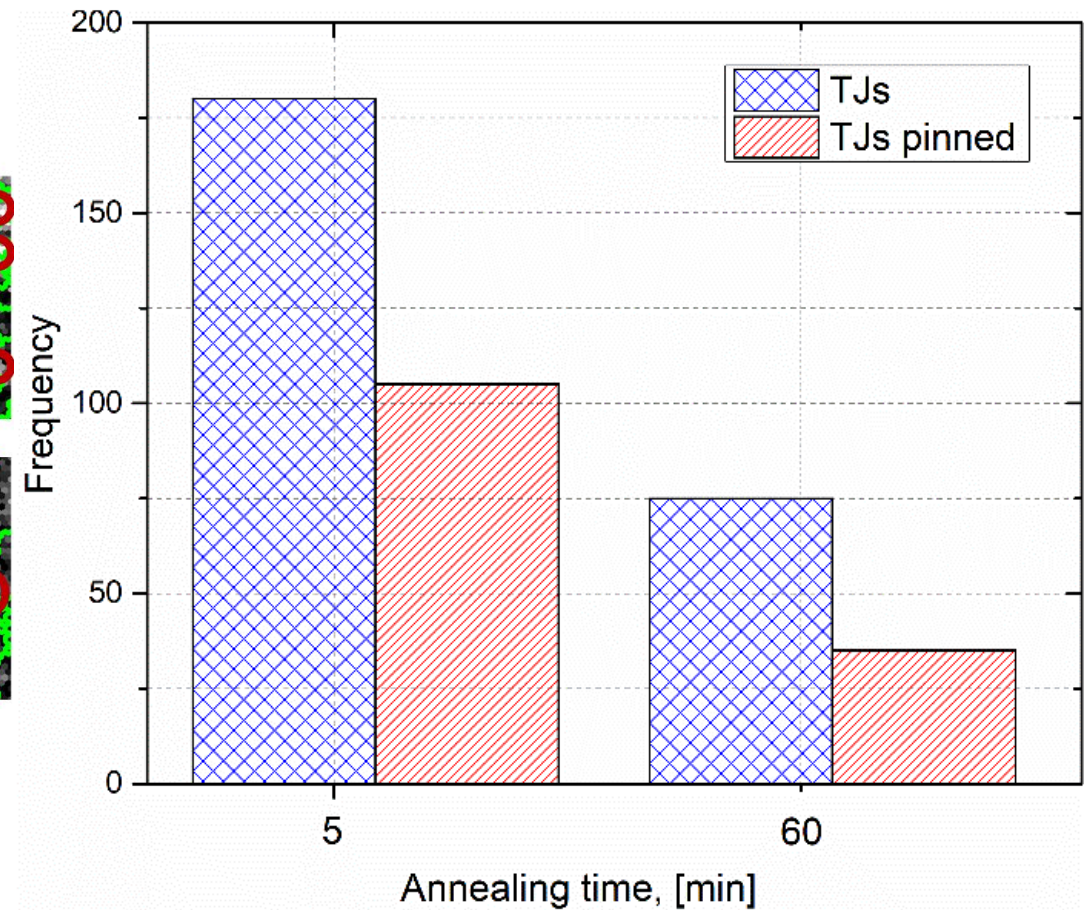
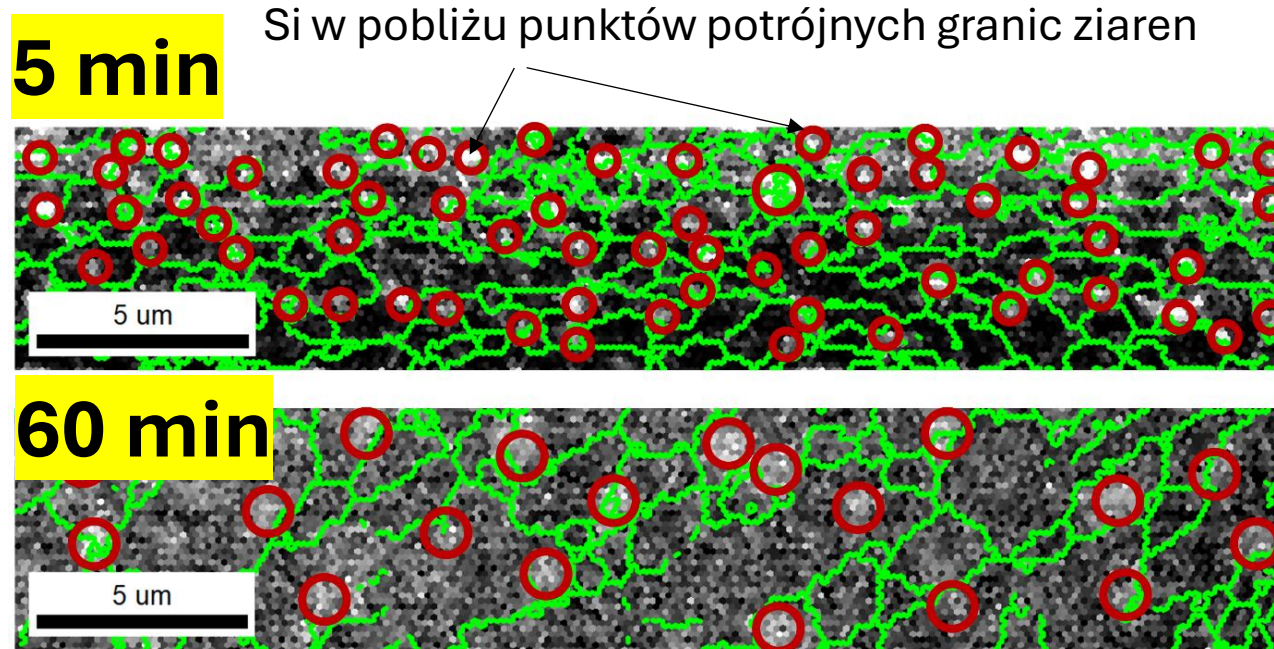
Stabilność termiczna mikrostruktury



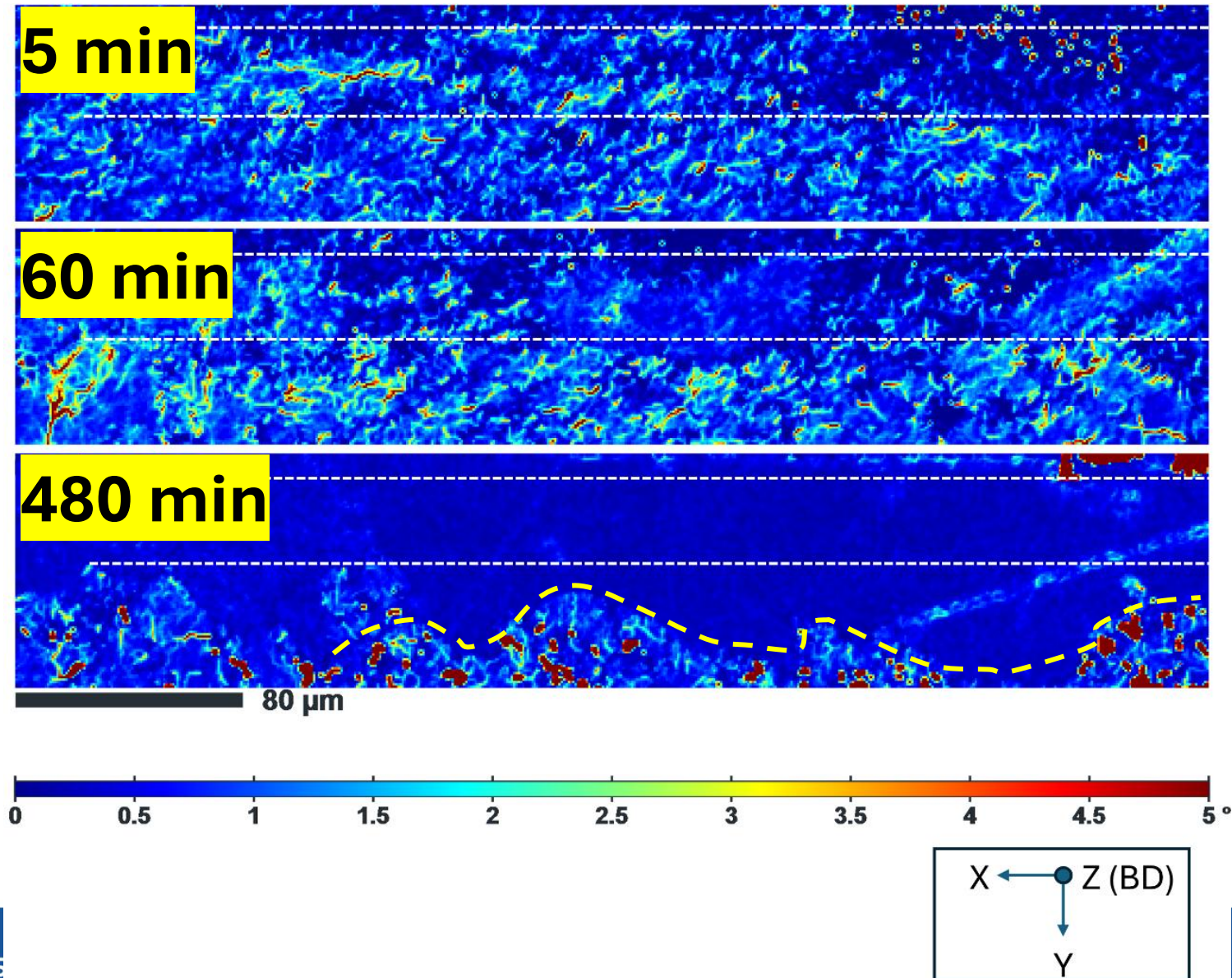
	5min		1h		8h	
	Particle size, μm	Particle spacing, μm	Particle size, μm	Particle spacing, μm	Particle size, μm	Particle spacing, μm
Topmost layer	0.31	0.37	0.47	1.32	0.54	1.79
Transition layer	0.28	0.39	0.49	1.85	0.55	1.98
Matrix	0.24	0.28	0.43	1.64	0.57	1.86



Stabilność termiczna mikrostruktury



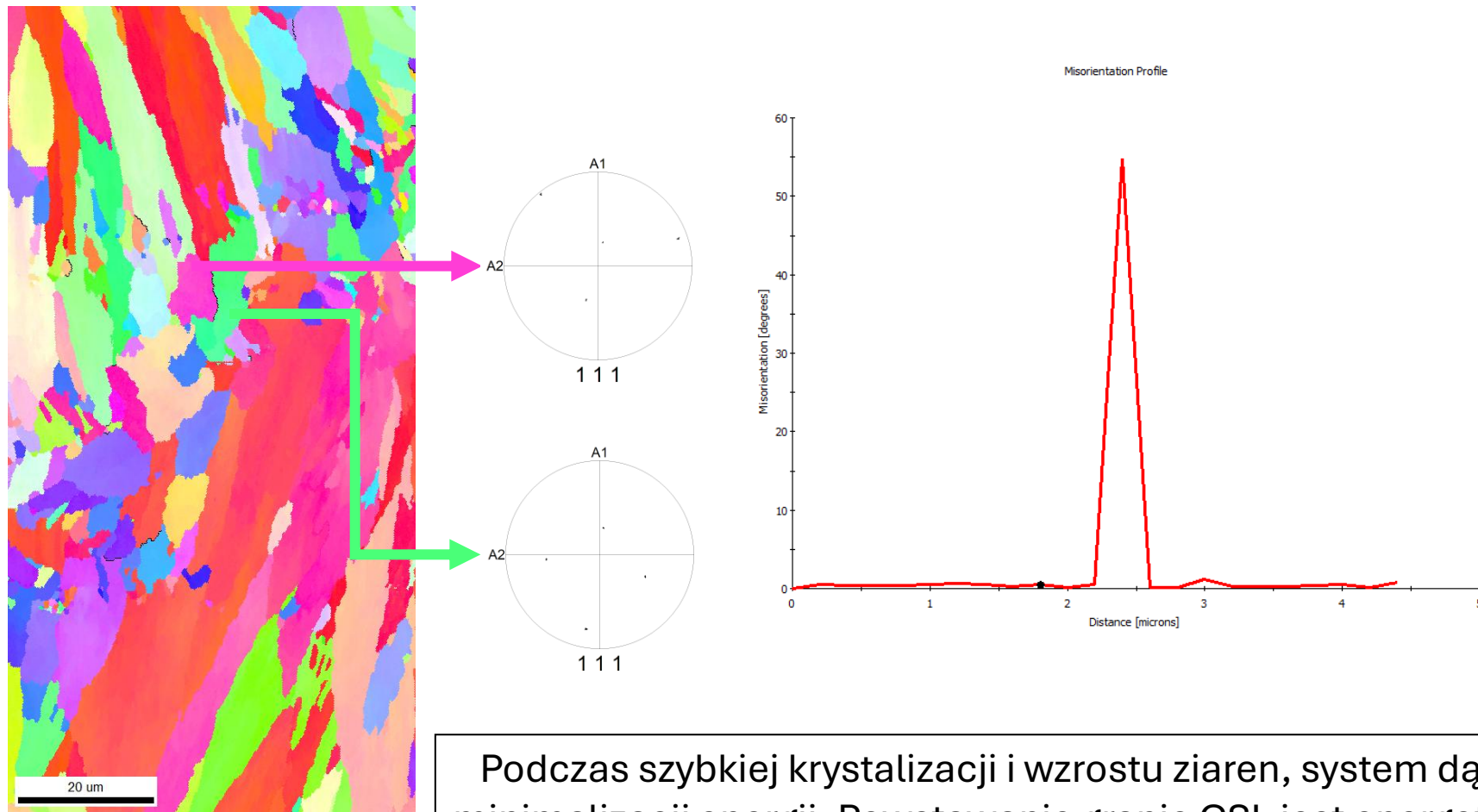
Stabilność termiczna mikrostruktury



INŻYNIERIA GRANIC MIĘDZYKRystalicznych (IGM) W STOPIE ALSI10MG / STABILNOŚĆ TERMICZNA MIKROSTRUKTURY PO PROCESIE KOBO

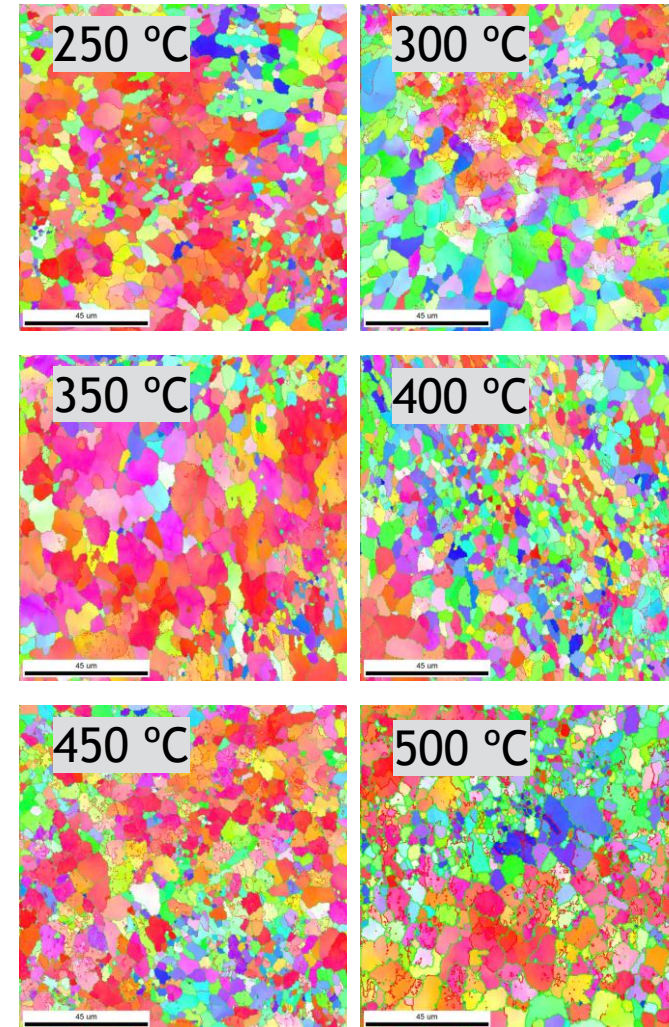
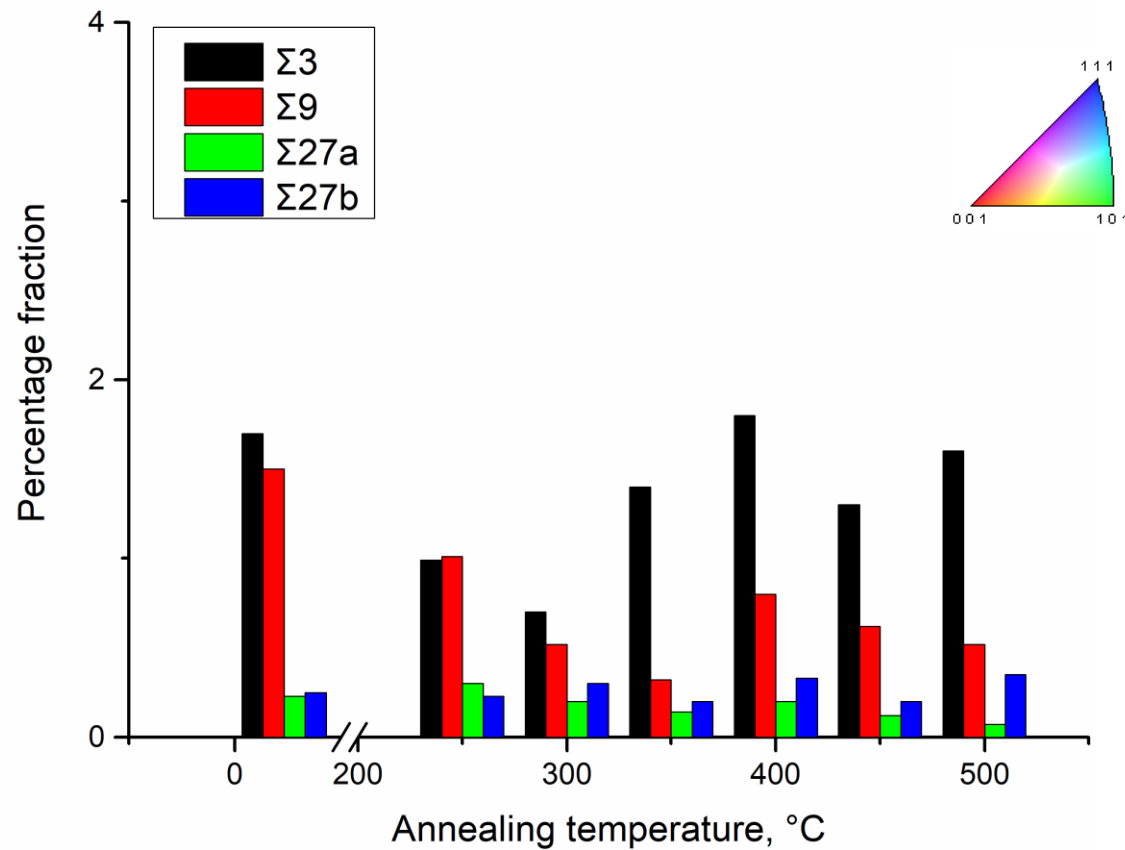


Granice specjalne – AlSi10Mg LPBF

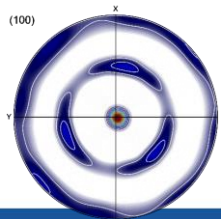
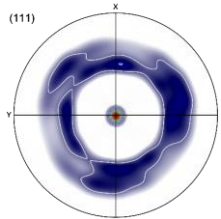
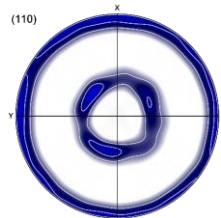
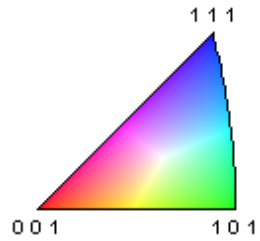


Podczas szybkiej krystalizacji i wzrostu ziaren, system dąży do minimalizacji energii. Powstawanie granic CSL jest energetycznie korzystne – mogą tworzyć się spontanicznie.

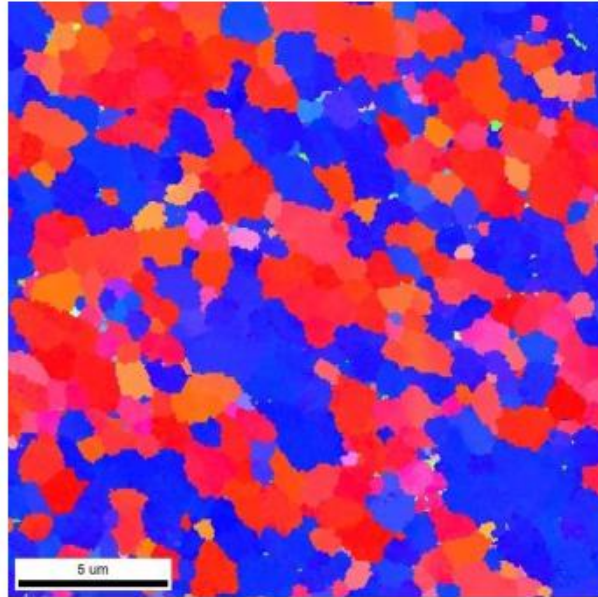
Wykorzystanie naprężeń resztkowych do aktywacji IGM



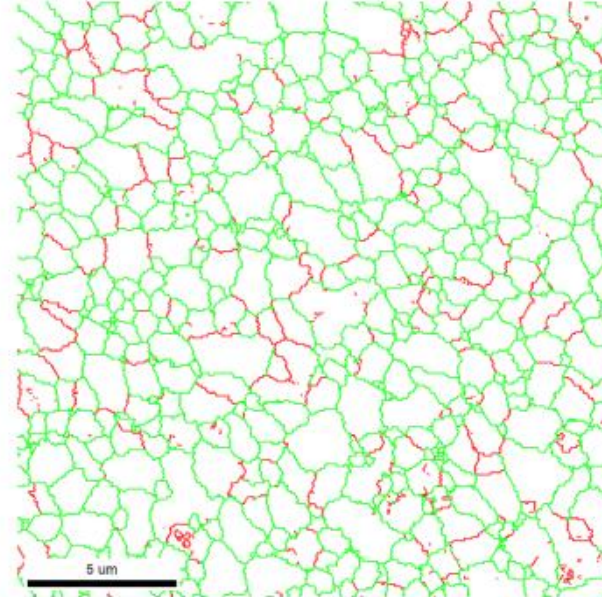
Mikrostruktura stopu AlSi10Mg po procesie KOB



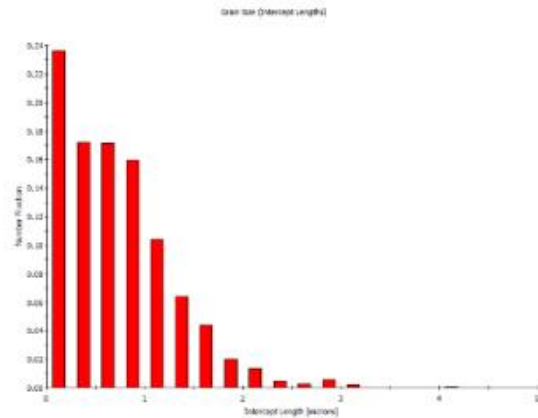
a)



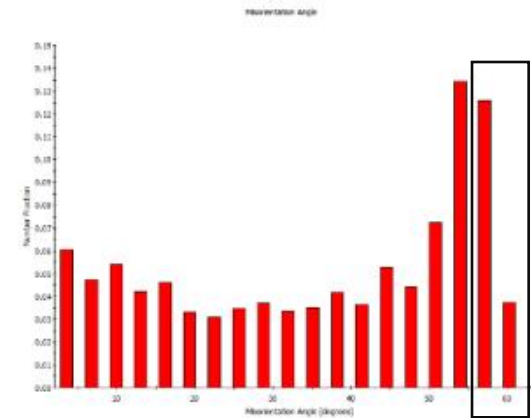
b)



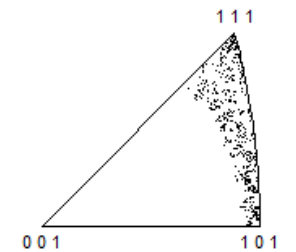
c)



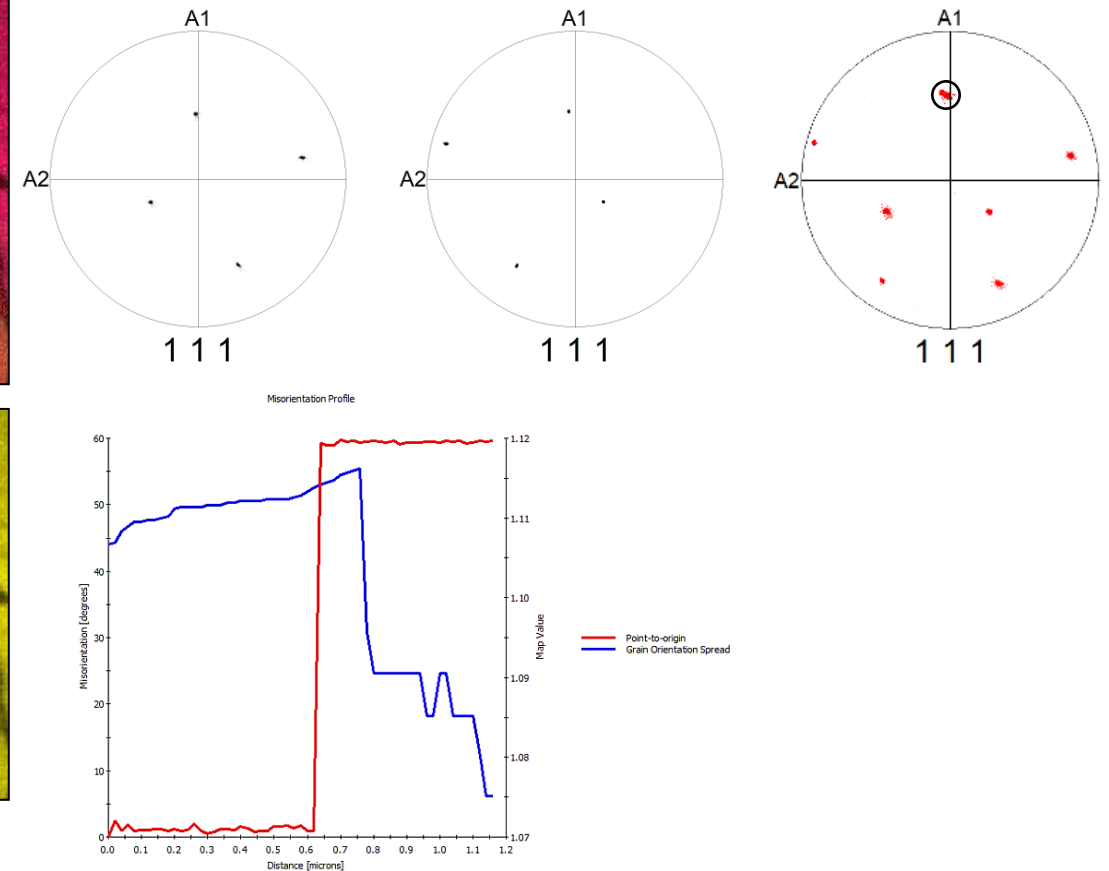
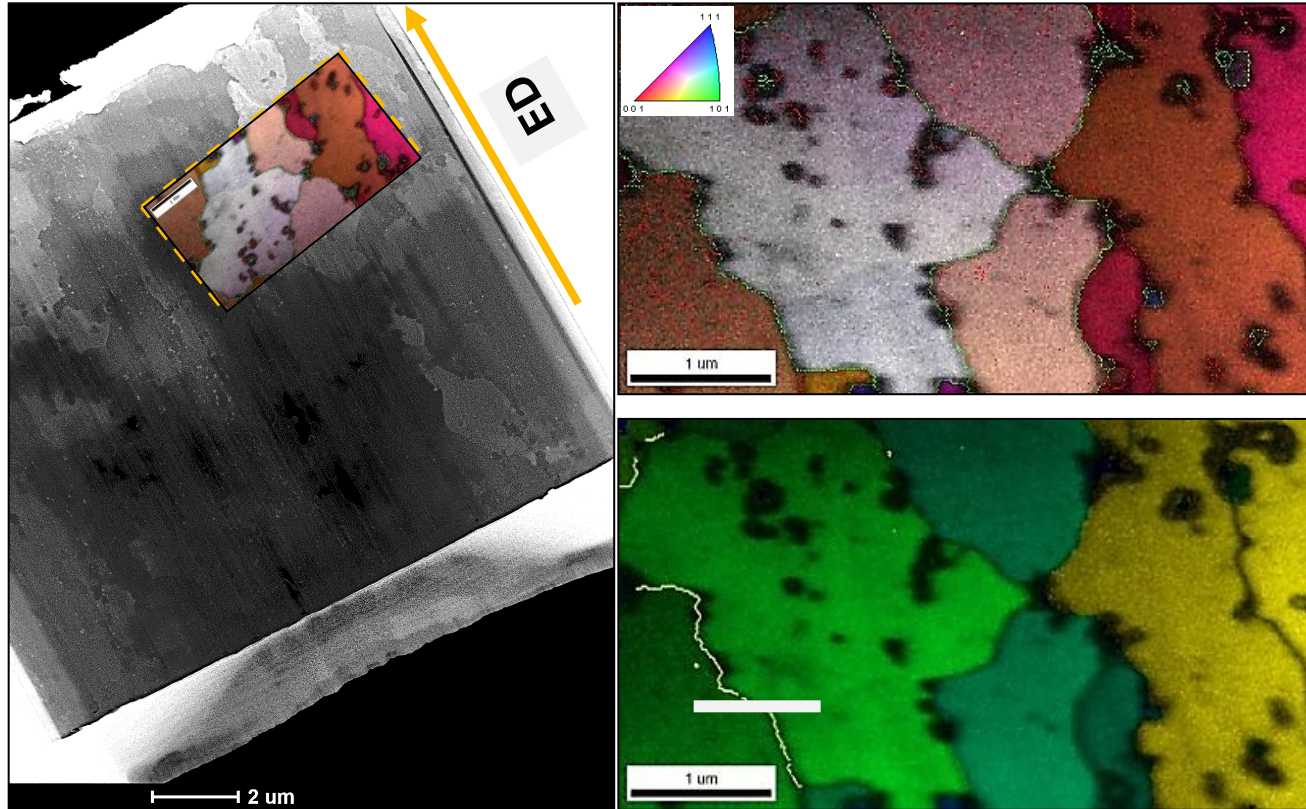
d)



60°



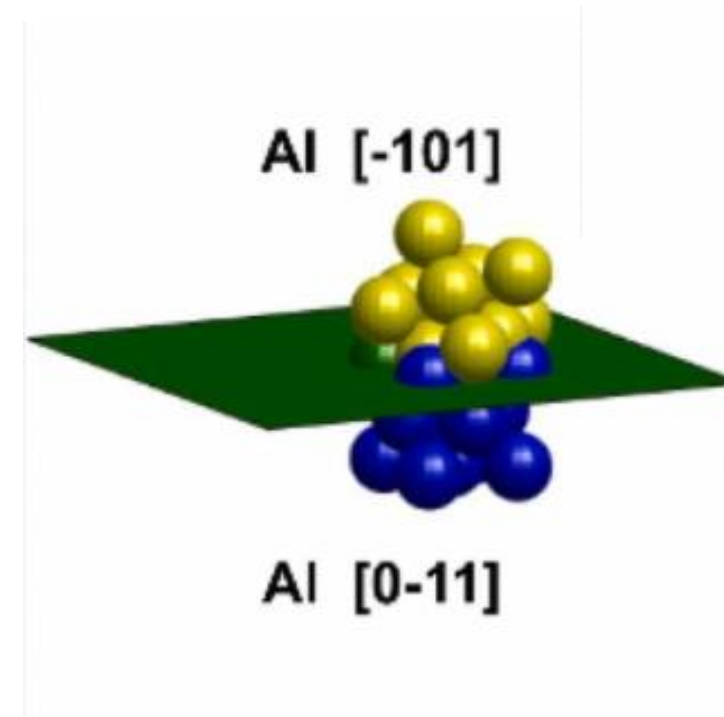
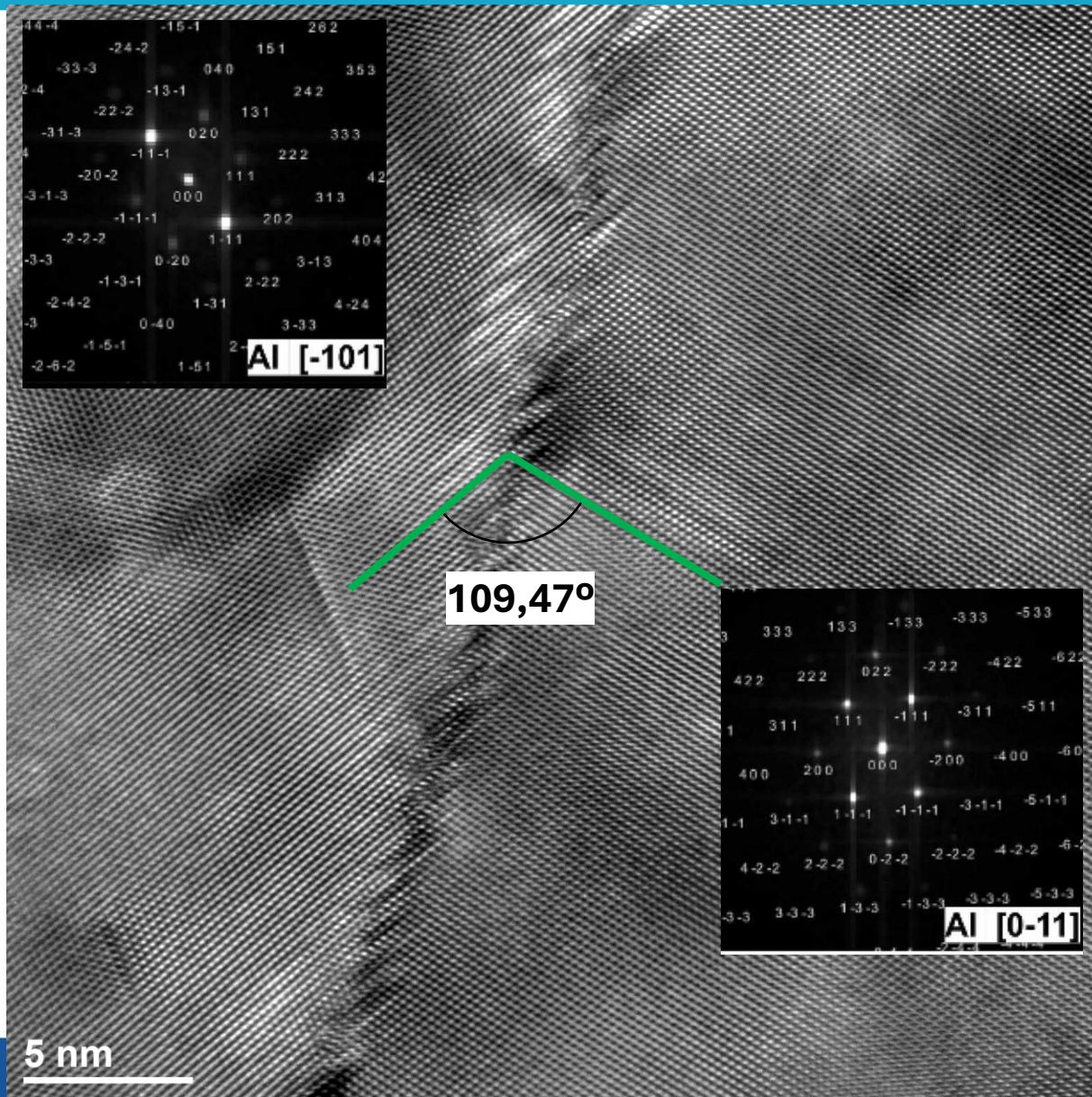
Mikrostruktura stopu AlSi10Mg po procesie KOB



Wyniki analizy mikrostruktury stopu AlSi10Mg wykonanej techniką dyfrakcji linii Kikuchiego w trybie transmisyjnym



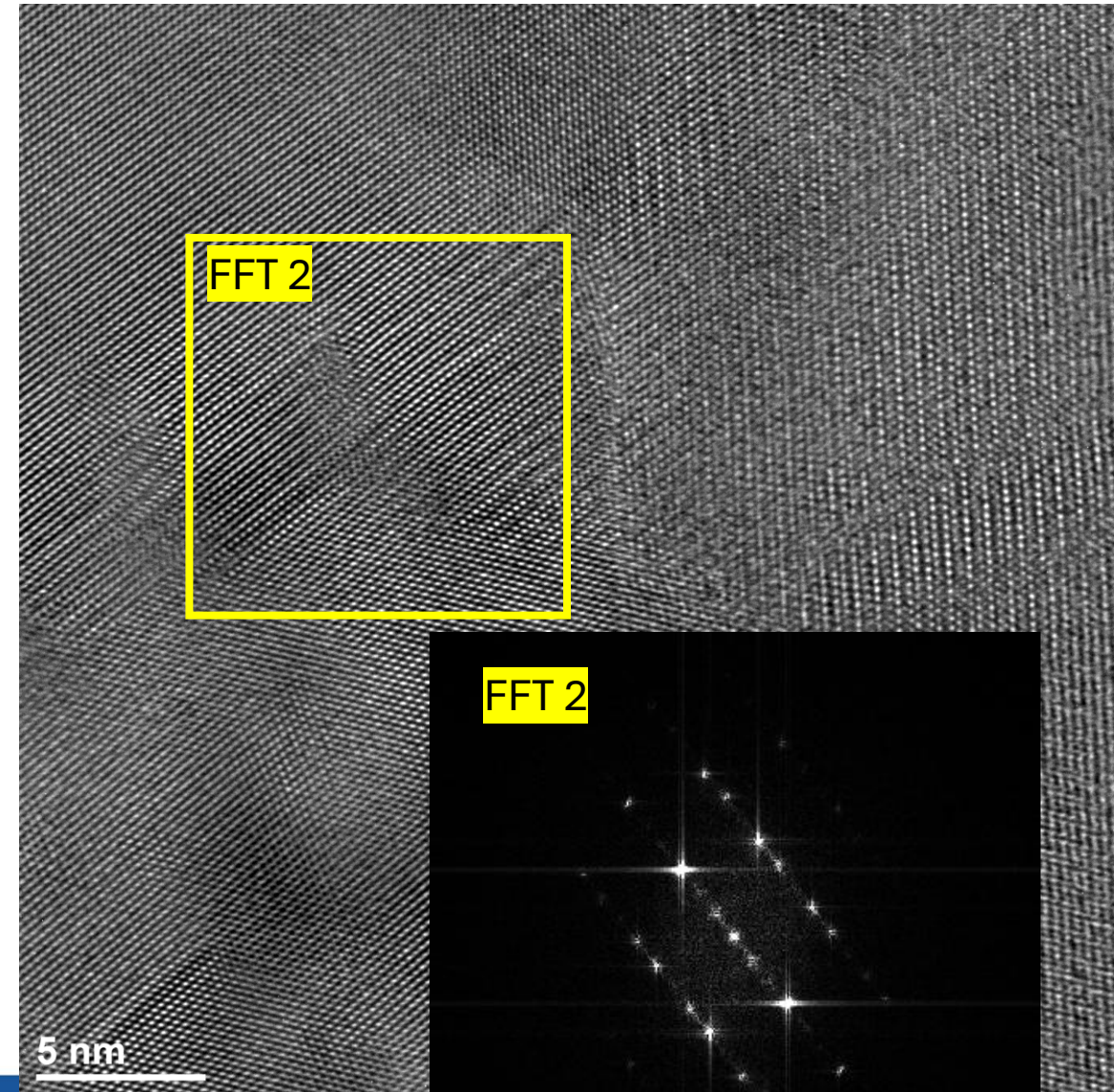
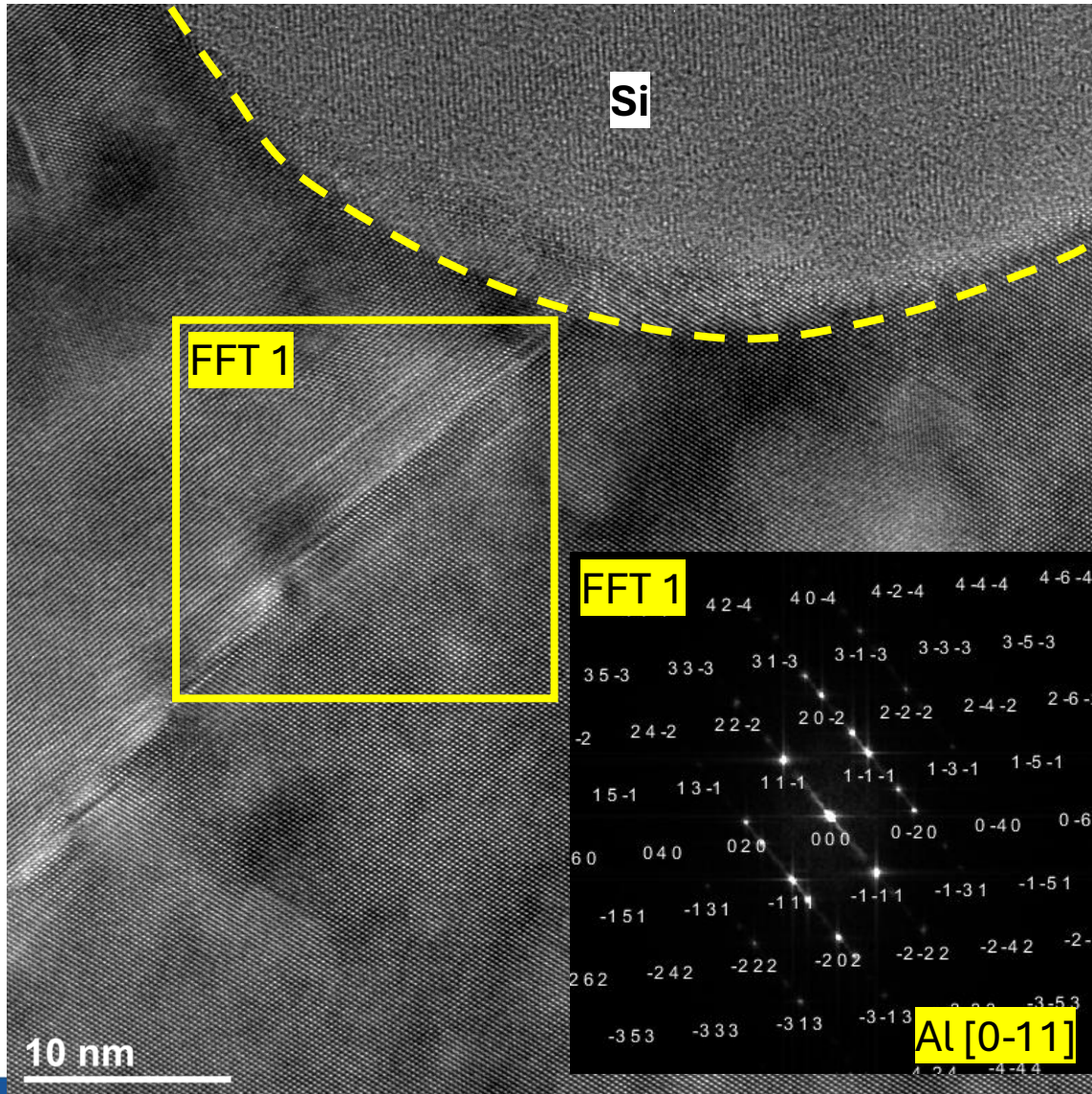
Mikrostruktura stopu AlSi10Mg po procesie KOB



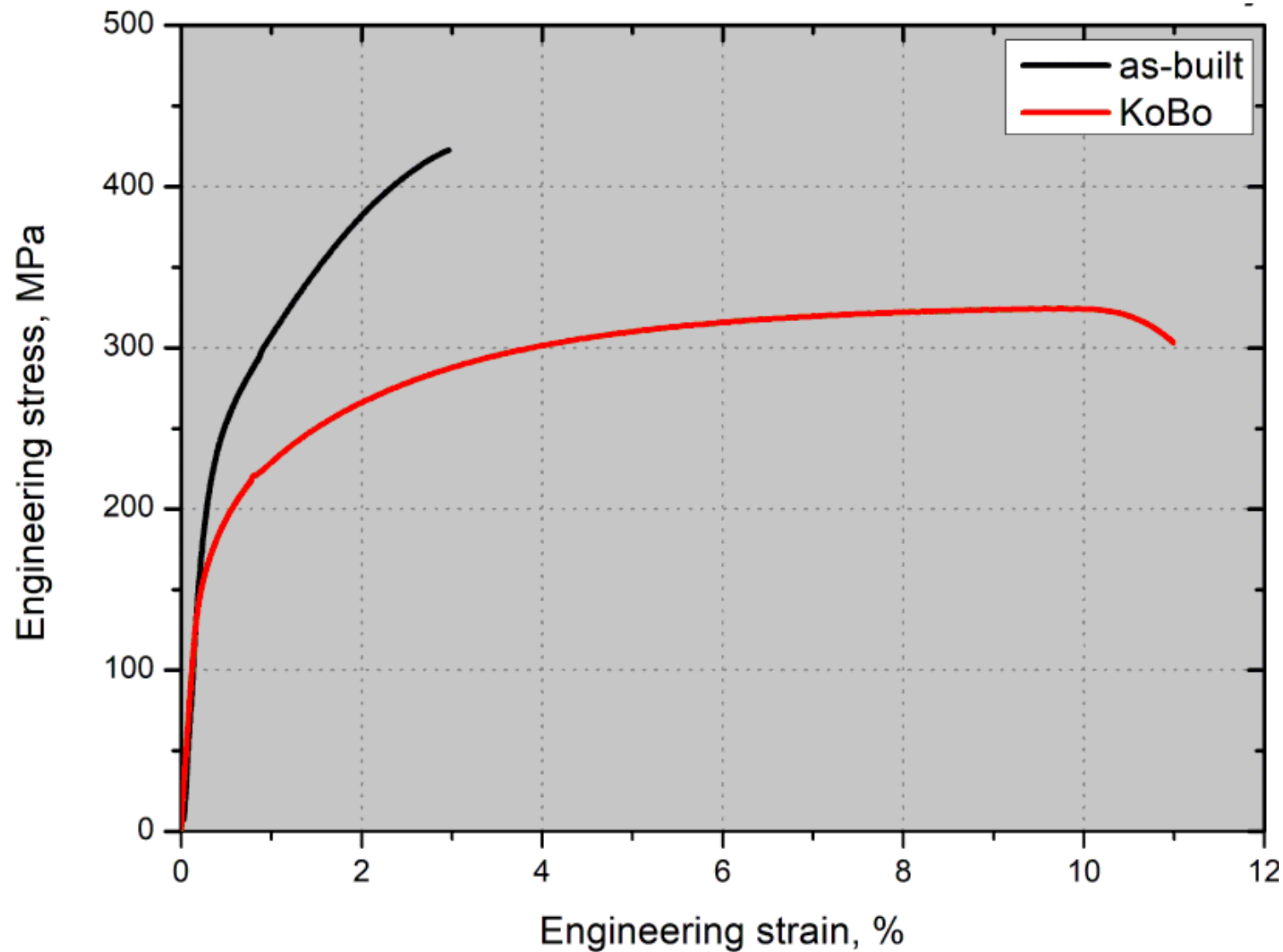
Model atomowy granicy



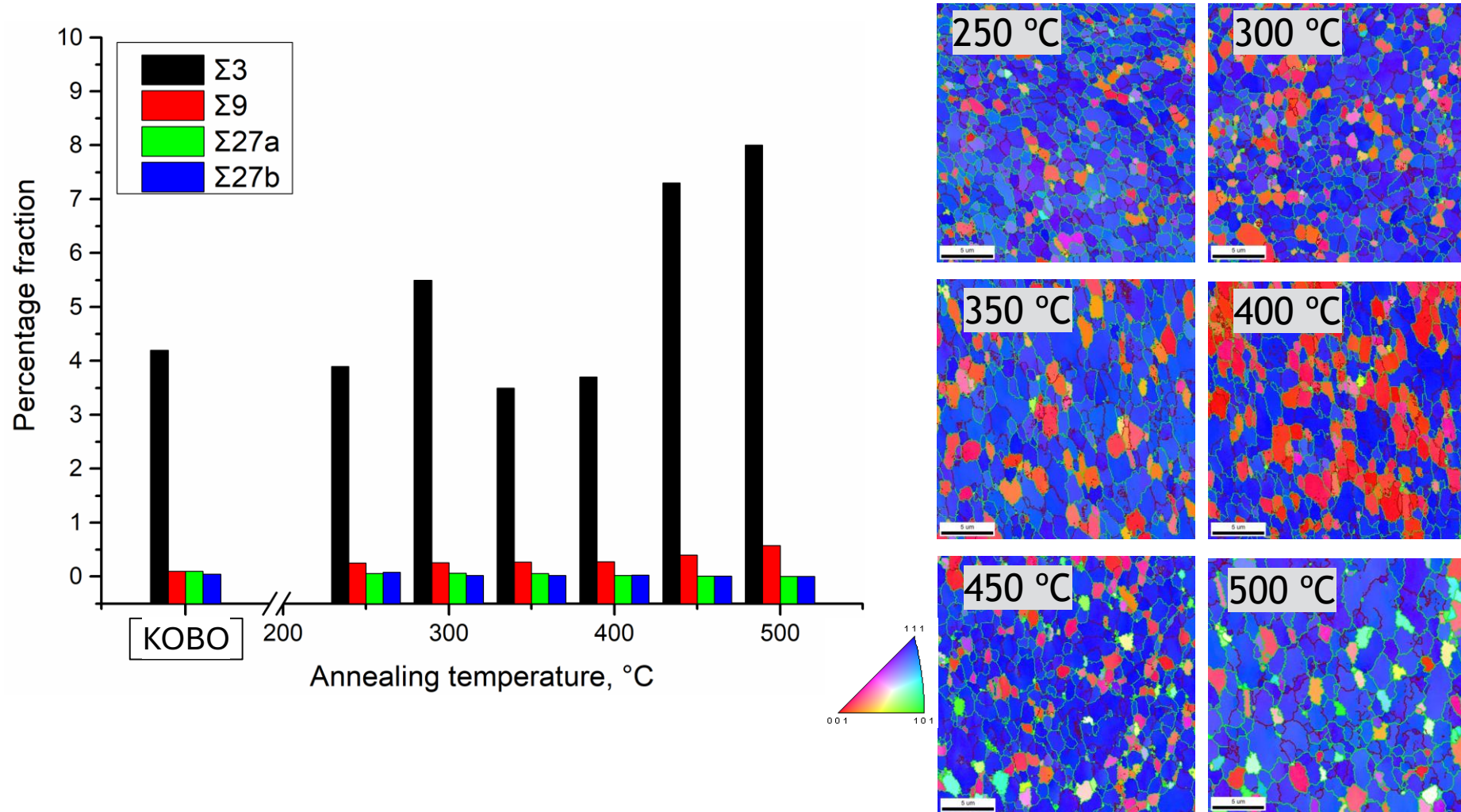
Mikrostruktura stopu AlSi10Mg po procesie KOBO



Porównanie własności mechanicznych



Stabilność termiczna mikrostruktury po procesie KOBO



Dziękuję za uwagę

Badania finansowane przez Narodowe Centrum Nauki w ramach projektów:

- SONATA 17 - 2021/43/D/ST8/01946
- OPUS 27 - 2024/53/B/ST8/03574

